CY91F463NA/F463NC/V460A

FR60, CY91460N Series, 32-bit Microcontroller Datasheet

CY91F463NA is a line of the general-purpose 32-bit RISC microcontrollers designed for embedded control applications which require high-speed real-time processing, such as consumer devices and on-board vehicle systems. CY91F463NA uses the FR60 CPU which is compatible with the FR CPUs.

CY91F463NA contains the LIN-USART and CAN controllers.

Note: CY91F463NC improved the features of CY91F463NA and updated the sector map for the flash memory. Please select CY91F463NC for the future development.

Features

FR60 CPU

- 32-bit RISC, load/store architecture, five-stage pipeline
- Maximum operating frequency: 80 MHz (oscillator frequency: 4 MHz; oscillator frequency multiplier: 20 (PLL clock multiplication method))
- 16-bit fixed-length instructions (basic instructions)
- Instruction execution speed: 1 instruction per cycle
- Instructions including memory-to-memory transfer, bit manipulation instructions, and barrel shift instructions: Instructions suitable for embedded applications
- Function entry/exit instructions and register data multi load store instructions: Instructions supporting C language
- Register interlock function: Facilitating assembly-language coding
- Built-in multiplier with instruction-level support

Signed 32-bit multiplication: 5 cycles
Signed 16-bit multiplication: 3 cycles

- Interrupt (PC/PS saving): 6 cycles (16 priority levels)
- Harvard architecture allowing program access and data access to be executed simultaneously
- Instructions compatible with the FR family

Internal Peripheral Resources

- Flash memory capacity : 288 Kbytes
- Internal RAM capacity: 8 Kbytes (Data RAM) + 2 Kbytes (Instruction/data RAM)
- General-purpose port: Maximum 48 ports
- DMAC (DMA Controller)

Maximum of 5 channels for able to operate simultaneously

2 transfer sources (internal peripheral/software)

Activation source can be selected by programs

Addressing mode specifies full 32-bit addresses (increment/decrement/fixed)

Transfer mode (burst transfer/step transfer/block transfer)

Transfer data size selectable from 8/16/32-bit

Multi-byte transfer capable (by programs)

DMAC descriptor in I/O areas (200_H to 240_H, 1000_H to 1024_H)

- A/D converter (sequential comparison)

10-bit resolution: 8 channels

Conversion time: 1 μs (using at 5 V) , 3 μs (using at 3.3 V)

- External interrupt inputs: 10 channels
- Bit search module (for REALOS)

Function to search from the MSB (most significant bit) for the position of the first "0", "1" or changed bit in a word

- LIN-USART (full duplex double buffer): 4 channels

Clock synchronous/asynchronous selectable

Sync-break detection

Internal dedicated baud rate generator

- I^2C bus interface (Supports 400 kbps): 2 channels

Master/slave transmission and reception

Arbitration function, clock synchronization function

- CAN controller (C-CAN): 2 channels

Maximum transfer speed: 1 Mbps

32 transmission/reception message buffers

- 16-bit PPG timer: 8 channels
- 16-bit reload timer: 4 channels + 1 channel (exclusive A/D converter)
- 16-bit free-run timer: 4 channels
- Input capture: 4 channels

- Output compare: 4 channels
- 8/16-bit up/down counter: 2 channels (8-bit)/1channel (16-bit)
- Watchdog timer
- Real-time clock
- Low-power consumption mode: Sleep/stop mode function

Package: LQFP-64 (LQG064)
CMOS 0.18 μm technology
3.3 V only power supplies or 5 V only power supplies
Operating temperature range:
– 40°C to + 85°C (using at 5 V)
– 40°C to + 105°C (using at 3.3 V)

Contents

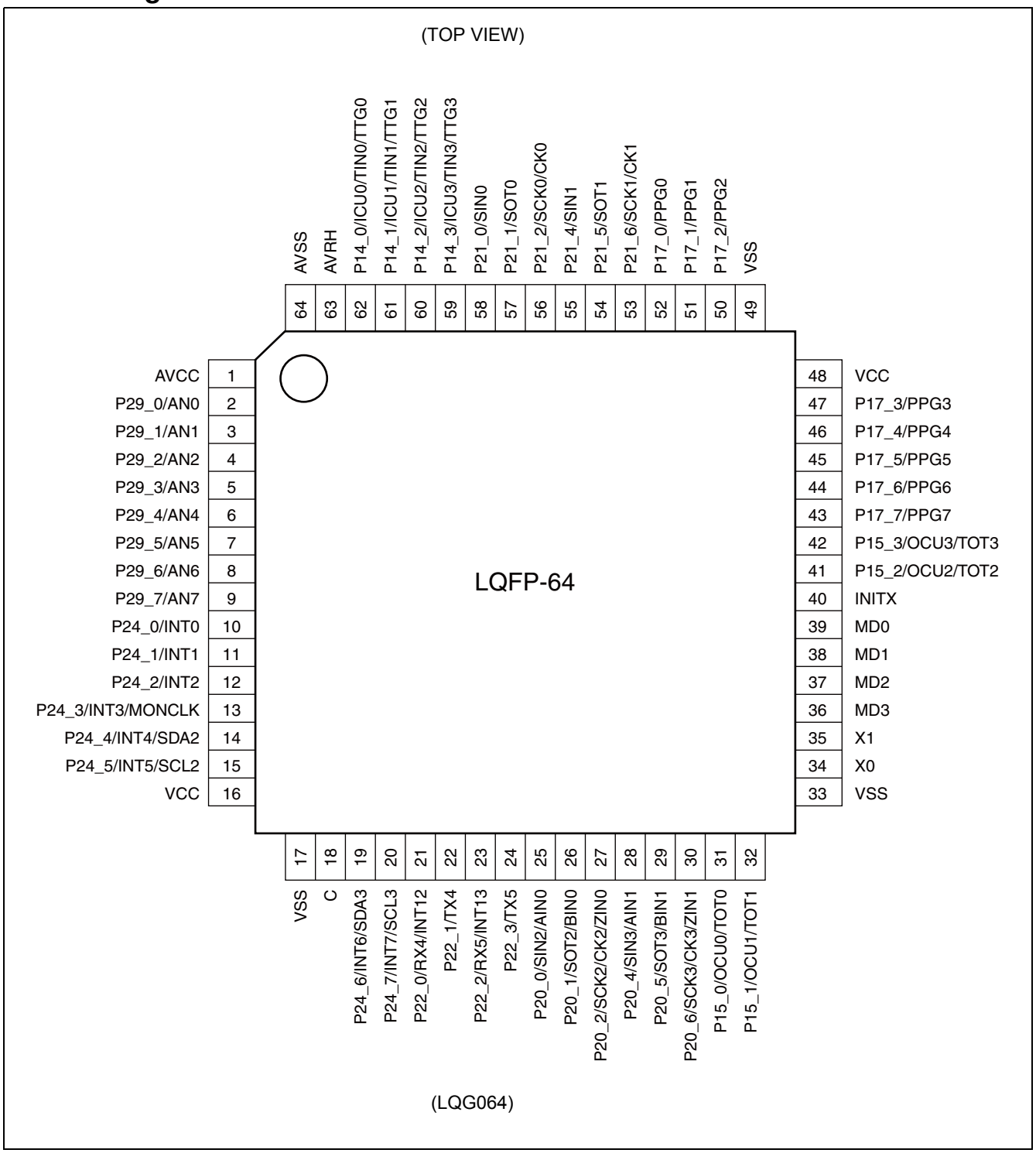
1. Product Lineup

Parameter \ Part Number	CY91V460A	CY91F463NA CY91F463NC
Max core frequency (CLKB)	80 MHz	
Max resource frequency (CLKP)	40 MHz	
Max external bus frequency (CLKT)	40 MHz	-
Max CAN frequency (CLKCAN)	20 MHz	
Technology	0.35 μm	0.18 μm
Watchdog Timer	Yes	No
Watchdog Timer (CR oscillator)	Yes (disengageable)	Yes
Bit search	Yes	
Reset input (INITX)	Yes	
Hardware standby input (HSTX)	Yes	No
Clock modulator	Yes	
Low-power mode	Yes	
DMAC	5 channels	
MAC (μDSP)	No	
MMU/MPU	MPU (16 channels)[1]	MPU (4 channels)[1]
Flash memory	Emulation SRAM 32-bit read data	288 Kbytes
Flash protection	-	Yes
Data RAM	64 Kbytes	8 Kbytes
Instruction/data RAM	64 Kbytes	2 Kbytes
Flash-cache (instruction cache)	16 Kbytes	4 Kbytes
Boot-ROM/BI-ROM	4 Kbytes fixed	4 Kbytes (BI-ROM)
Real-time clock	1 channels	
Free-run timer	8 channels	4 channels
ICU	8 channels	4 channels
OCU	8 channels	4 channels
16-bit reload timer	8 channels	4 channels + 1 channel
16-bit PPG	16 channels	8 channels

Part Number / Parameter	CY91V460A	CY91F463NA CY91F463NC
16-bit PFM	1 channel	No
Sound Generator	1 channel	No
8/16-bit up/down counter	4 channels (8-bit) / 2 channels (16-bit)	2 channels (8-bit) /1 channel (16-bit)
C_CAN	6 channels (128 message buffers)	2 channels (32 message buffers)
LIN-USART	4 channels + 4 channels (FIFO) + 8 channels	4 channels
I^2C (400 kbps)	4 channels	2 channels
FR external bus	Yes (32-bit address, 32-bit data)	No
External interrupt	16 channels	10 channels
NMI interrupts	Yes	No
Stepping motor controller (SMC)	6 channels	No
LCD controller (40 4)	1 channel	No
10-bit A/D converter	32 channels	8 channels
Alarm comparator	2 channels	No
Clock supervisor	Yes	No
Main clock oscillator	4 MHz	
Sub clock oscillator	32 kHz	-
CR oscillator	100 kHz	100 kHz / 2 MHz
PLL	× 20	
DSU4	Yes	No
EDSU	Yes (32 BP) [1]	Yes (8 BP)[1]
Power supply voltage	3 V / 5 V	
Regulator	Yes	
Power consumption	n.a.	< 700 mW
Temperature range (T_A)	0 °C to +70°C	− 40 °C to + 105°C
Package	BGA-660	LQFP-64

1. MPU channels use EDSU breakpoint registers (shared operation between MPU and EDSU).

2. Pin Assignment



3. Pin Description

Pin No.	Pin Name	I/O	I/O Circuit Type[1]	Function
2 to 9	P29_0 to P29_7	I/O	B	General-purpose input/output ports
	AN0 to AN7			Analog input pins for A/D converter
10 to 12	P24_0 to P24_2	I/O	A	General-purpose input/output ports
	INT0 to INT2			External interrupt input pins
13	P24_3	I/O	A	General-purpose input/output port
	INT3			External interrupt input pins
	MONCLK			Clock monitor output pin
14	P24_4	I/O	C	General-purpose input/output port
	INT4			External interrupt input pin
	SDA2			I^2C bus data input/output pin
15	P24_5	I/O	C	General-purpose input/output port
	INT5			External interrupt input pin
	SCL2			I^2C bus clock input/output pin
19	P24_6	I/O	C	General-purpose input/output port
	INT6			External interrupt input pin
	SDA3			I^2C bus data input/output pin
20	P24_7	I/O	C	General-purpose input/output port
	INT7			External interrupt input pin
	SCL3			I^2C bus clock input/output pin
21	P22_0	I/O	A	General-purpose input/output port
	RX4			RX input pin of CAN4
	INT12			External interrupt input pin
22	P22_1	I/O	A	General-purpose input/output port
	TX4			TX output pin of CAN4
23	P22_2	I/O	A	General-purpose input/output port
	RX5			RX input pin of CAN5
	INT13			External interrupt input pin
24	P22_3	I/O	A	General-purpose input/output port
	TX5			TX output pin of CAN5
25	P20_0	I/O	A	General-purpose input/output port
	SIN2			Data input pin of LIN-USART2
	AIN0			Up/down counter input pin
26	P20_1	I/O	A	General-purpose input/output port
	SOT2			Data output pin of LIN-USART2
	BIN0			Up/down counter input pin
27	P20_2	I/O	A	General-purpose input/output port
	SCK2			Clock input/output pin of LIN-USART2
	CK2			Free-run timer input pin
	ZIN0			Up/down counter input pin
28	P20_4	I/O	A	General-purpose input/output port
	SIN3			Data input pin of LIN-USART3
	AIN1			Up/down counter input pin

Pin No.	Pin Name	I/O	I/O Circuit Type[1]	Function
29	P20_5	I/O	A	General-purpose input/output port
	SOT3			Data output pin of LIN-USART3
	BIN1			Up/down counter input pin
30	P20_6	I/O	A	General-purpose input/output port
	SCK3			Clock input/output pin of LIN-USART3
	CK3			Free-run timer input pin
	ZIN1			Up/down counter input pin
31	P15_0	I/O	A	General-purpose input/output port
	OCU0			Output compare output pin
	TOT0			Reload timer output pin
32	P15_1	I/O	A	General-purpose input/output port
	OCU1			Output compare output pin
	TOT1			Reload timer output pin
34	X0	–	J	Clock (oscillation) input
35	X1	–	J	Clock (oscillation) output
36	MD3	I	I	Mode setting pin
37	MD2	I	G	Mode setting pin
38	MD1	I	G	Mode setting pin
39	MD0	I	G	Mode setting pin
40	INITX	I	H	External reset input
41	P15_2	I/O	A	General-purpose input/output port
	OCU2			Output compare output pin
	TOT2			Reload timer output pin
42	P15_3	I/O	A	General-purpose input/output port
	OCU3			Output compare output pin
	TOT3			Reload timer output pin
43 to 47, 50 to 52	P17_7 to P17_0	I/O	A	General-purpose input/output ports
	PPG7 to PPG0			PPG timer output pins
53	P21_6	I/O	A	General-purpose input/output port
	SCK1			Clock input/output pin of LIN-USART1
	CK1			Free-run timer input pin
54	P21_5	I/O	A	General-purpose input/output port
	SOT1			Data output pin of LIN-USART1
55	P21_4	I/O	A	General-purpose input/output port
	SIN1			Data input pin of LIN-USART1
56	P21_2	I/O	A	General-purpose input/output port
	SCK0			Clock input/output pin of LIN-USART0
	CK0			Free-run timer input pin
57	P21_1	I/O	A	General-purpose input/output port
	SOT0			Data output pin of LIN-USART0
58	P21_0	I/O	A	General-purpose input/output port
	SIN0			Data input pin of LIN-USART0

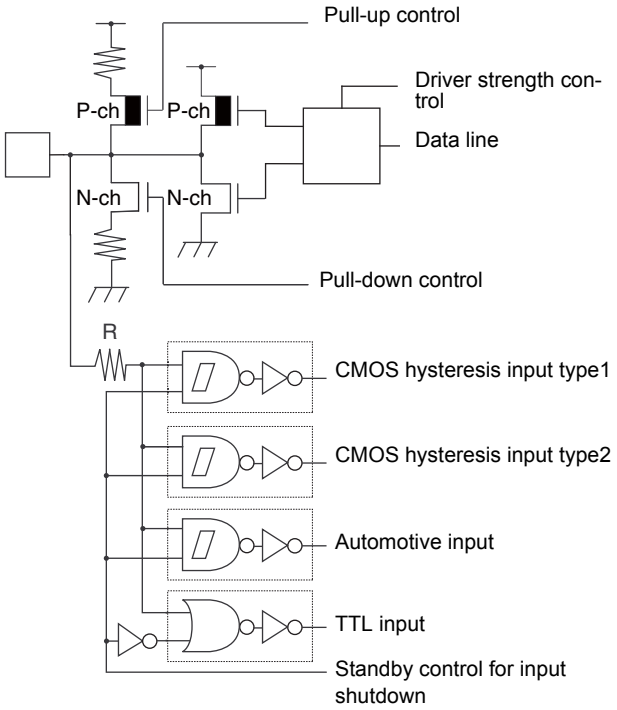
Pin No.	Pin Name	I/O	I/O Circuit Type[1]	Function
59	P14_3	I/O	A	General-purpose input/output port
	ICU3			Input capture input pin
	TIN3			External trigger input pin of reload timer
	TTG3			PPG timer input pin
60	P14_2	I/O	A	General-purpose input/output port
	ICU2			Input capture input pin
	TIN2			External trigger input pin of reload timer
	TTG2			PPG timer input pin
61	P14_1	I/O	A	General-purpose input/output port
	ICU1			Input capture input pin
	TIN1			External trigger input pin of reload timer
	TTG1			PPG timer input pin
62	P14_0	I/O	A	General-purpose input/output port
	ICU0			Input capture input pin
	TIN0			External trigger input pin of reload timer
	TTG0			PPG timer input pin

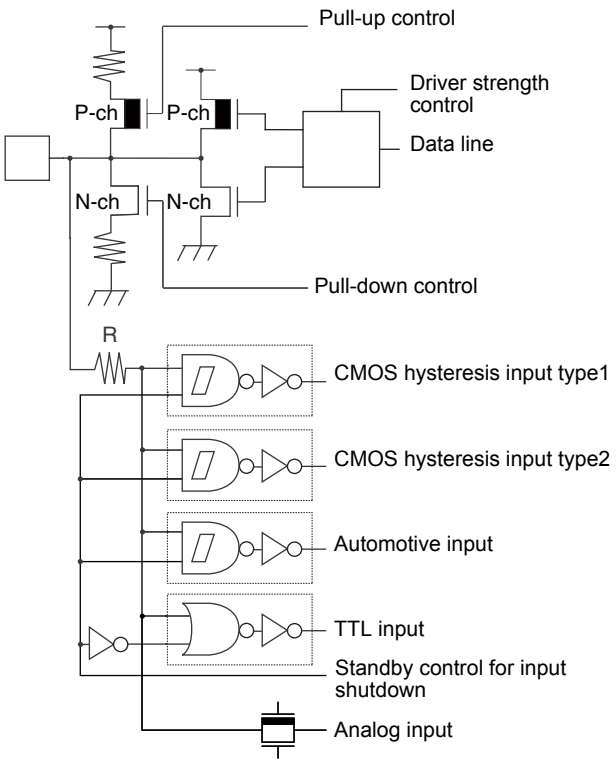
1. For I/O circuit type, refer to " I/O Circuit Type".

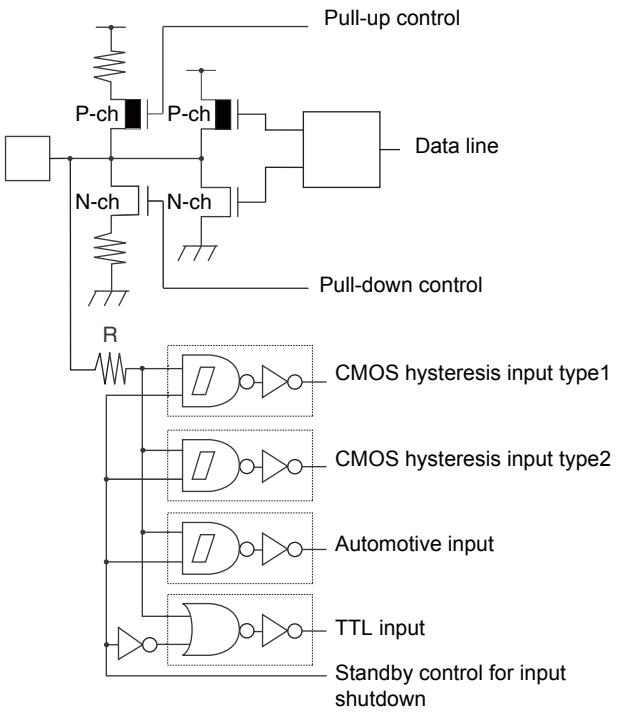
3.1 Power Supply/GND Pins

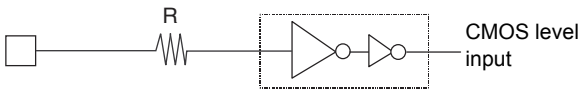
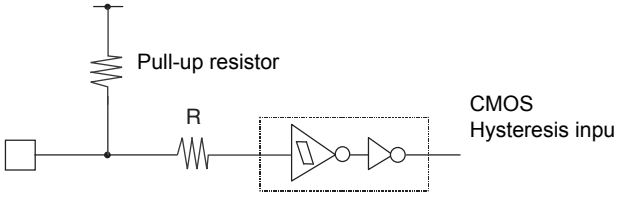
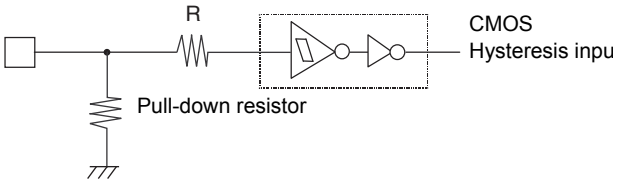
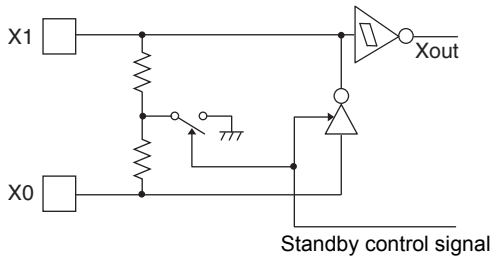
Pin No.	Pin Name	I/O	Function
17, 33, 49	VSS	-	GND pins
16, 48	VCC	-	3.3 V/5 V power supply pins
64	AVSS	-	Analog GND pin for A/D converter
1	AVCC	-	3.3 V/5 V power supply pin for A/D converter
63	AVRH	-	Reference power supply pin for A/D converter
18	C	-	Capacitor connection pin for internal regulator

4. I/O Circuit Type

Type	Circuit	Remarks
A		■ CMOS level output (programmable I_{OL} = 5mA, I_{OH} = − 5mA, I_{OL} = 2mA, I_{OH} = − 2mA) ■ 2 different CMOS hysteresis inputs with input shutdown function ■ Automotive input with input shutdown function ■ TTL input with input shutdown function ■ Programmable pull-up resistor: approx.50 kΩ

Type	Circuit	Remarks
B		■ CMOS level output (programmable I_{OL} = 5 mA, I_{OH} = − 5 mA, I_{OL} = 2 mA, I_{OH} = − 2 mA) ■ 2 different CMOS hysteresis inputs with input shutdown function ■ Automotive input with input shutdown function ■ TTL input with input shutdown: approx.50 kΩ ■ Analog input

Type	Circuit	Remarks
C		■ CMOS level output (I_{OL} = 3 mA, I_{OH} = − 3 mA) ■ 2 different CMOS hysteresis inputs with input shutdown function ■ Automotive input with input shutdown function ■ TTL input with input shutdown function ■ Programmable pull-up resistor: approx.50 kΩ

Type	Circuit	Remarks
G		■ MASK ROM and evaluation device: CMOS level input ■ Flash device: ❒ CMOS level input ❒ 12 V resistant (for MD [2:0])
H		■ CMOS hysteresis input ■ Pull-up resistor value: approx.50 kΩ
I		■ CMOS hysteresis input ■ Pull-down resistor value: approx.50 kΩ
J		Oscillation circuit

5. Precautions for Handling The Devices

Any semiconductor devices have inherently a certain rate of failure. The possibility of failure is greatly affected by the conditions in which they are used (circuit conditions, environmental conditions, etc.). This page describes precautions that must be observed to minimize the chance of failure and to obtain higher reliability from your Cypress semiconductor devices.

5.1 Precautions for Product Design

This section describes precautions when designing electronic equipment using semiconductor devices.

■ Absolute Maximum Ratings

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ Recommended Operating Conditions

The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their Cypress representatives beforehand.

■ Processing and Protection of Pins

These precautions must be followed when handling the pins which connect semiconductor devices to power supply and input/output functions.

1. Preventing Over-Voltage and Over-Current Conditions
Exposure to voltage or current levels in excess of maximum ratings at any pin is likely to cause deterioration within the device, and in extreme cases leads to permanent damage of the device. Try to prevent such over voltage or over-current conditions at the design stage.
2. Protection of Output Pins
Shorting of output pins to supply pins or other output pins, or connection to large capacitance can cause large current flows. Such conditions if present for extended periods of time can damage the device. Therefore, avoid this type of connection.
3. Handling of Unused Input Pins
Unconnected input pins with very high impedance levels can adversely affect stability of operation. Such pins should be connected through an appropriate resistance to a power supply pin or ground pin.

■ Latch-up

Semiconductor devices are constructed by the formation of P-type and N-type areas on a substrate. When subjected to abnormally high voltages, internal parasitic PNPN junctions (called thyristor structures) may be formed, causing large current levels in excess of several hundred mA to flow continuously at the power supply pin. This condition is called latch-up.

Note:

The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:
(a) Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.
(b) Be sure that abnormal current flows do not occur during the power-on sequence.

■ Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

■ Fail-Safe Design

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

■ Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, submarine repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with Cypress sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

5.2 Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mounting type. In either case, quality assurance of heat resistance are applied for mounting under the Cypress's recommended conditions only at the soldering stage. For detailed information on mount conditions, contact the sales representative.

■ Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder.In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

■ Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges. You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

■ Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

(a) Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.

(b) Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between + 5°C to + 30°C.

(c) When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.

(d) Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

■ Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

■ Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

(a) Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.

(b) Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.

(c) Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ). Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.

(d) Ground all fixtures and instruments, or protect with anti-static measures.

(e) Avoid the use of styrofoam or other highly static-prone materials for storage of completed board assemblies.

5.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.
For reliable performance, do the following:

1. Humidity
   Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.
2. Discharge of Static Electricity
   When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.
3. Corrosive Gases, Dust, or Oil
   Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.
4. Radiation, Including Cosmic Radiation
   Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.
5. Smoke, Flame
   Note: Plastic molded devices are flammable, and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with Cypress sales representatives.

6. Handling Devices

■ Power supply pins

Because there are multiple VCC and VSS pins, respective pins at the same potential are interconnected to prevent malfunctions such as latch-up. However, you must connect the pins externally to the power supply and ground lines to reduce the electro-magnetic emission levels, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating. Furthermore, the current supply source should be connected to the VCC and VSS pins of the device at a low impedance.

It is recommended to connect a ceramic bypass capacitor of approximately 0.1 μF as a bypass capacitor between the V_{CC} and V_{SS} near this device.

■ Crystal oscillator circuit

Noise in proximity to the X0 and X1 pins can cause the device to malfunction. Printed circuit boards should be designed so that the X0 and X1 pins, crystal oscillator (or ceramic oscillator), and bypass capacitors connected to ground are located near the device and ground.

It is recommended that the printed circuit board artwork be designed such that the X0 and X1 pins are surrounded by ground plane for the stable operation.

Please request the oscillator manufacturer to evaluate the oscillational characteristics of the crystal and this device.

■ Mode pins (MD0 to MD3)

Connect them directly to VCC or VSS. To prevent the device from entering test mode accidentally due to noise, minimize the lengths of the patterns between each mode pin and VCC or VSS on the printed circuit board as much as possible and connect them at a low impedance. When used pulling down, design your circuit not to generate noises with a resistance 1 kΩ or less. Test your circuit and confirm that there is no problem.

■ Operation at power-on

At power-on, it is necessary to make the terminal INITX “L” level.

Maintain the “L” level input to the INITX pin for the duration of the stabilization wait time immediately after the power on to ensure the stabilization wait time as required by the oscillator circuit.

■ Note on oscillator input at power-on

At power-on, ensure that the clock is input until the oscillator stabilization wait time has elapsed.

■ Built-in regulator

As this series includes built-in step-down regulators, always connect a bypass capacitor of 4.7 μF or more to the C pin for use by the regulator.

■ Notes on power on/off

Connect/disconnect the power supply pins when power on/off, or turn on/off in the following order.
Power on : VCC → AVCC, AVRH
Power off : AVCC, AVRH → VCC

■ Precautions for the STOP mode

Set 1 to the bit 0 (OSCD1) of STCR register. When shifting to the STOP mode, a regulator switches to the stand-by regulator (for low-consumption current).Due to the limited drive current, stop the (programming/erasing) access to the A/D converter and Flash before shifting to the STOP mode.

■ Serial communication

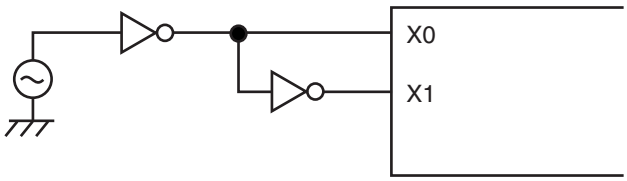
There is a possibility to receive wrong data due to the noise or other causes on the serial communication. Therefore, design a board so as to avoid noise.

Consider receiving of wrong data when designing the system. For example, apply a checksum to detect an error. If an error is detected, retransmit the data.

■ Notes on using external clock

When using the external clock, as a general rule you should simultaneously supply X0 and X1 pins. And also, the clock signal to X0 should be supplied a clock signal with the reverse phase to X1 pins. However, in this case the stop mode (oscillation stop mode) must not be used.

Example of using external clock (normal)



Note: Stop mode (oscillation stop mode) cannot be used.

■ Notes on operating in PLL clock mode

If the oscillator is disconnected or the clock input stops when the PLL clock is selected, the microcontroller may continue to operate at the free-running frequency of the self-oscillating circuit of the PLL. However, this self-running operation cannot be guaranteed.

7. Notes on Debugger

7.1 Execution of the RETI Command

If single-step execution is used in an environment where an interrupt occurs frequently, the corresponding interrupt handling routine will be executed repeatedly to the exclusion of other processing. This will prevent the main routine and the handlers for low priority level interrupts from being executed (For example, if the time-base timer interrupt is enabled, stepping over the RETI instruction will always break on the first line of the time-base timer interrupt handler).

Disable the corresponding interrupts when the corresponding interrupt handling routine no longer needs debugging.

7.2 Break Function

If the range of addresses that cause a hardware break (including event breaks) is set to the address of the current system stack pointer or to an area that contains the stack pointer, execution will break after each instruction regardless of whether the user program actually contains data access instructions.

To prevent this, do not set (word) access to the area containing the address of the system stack pointer as the target of the hardware break (including an event breaks).

7.3 Operand Break

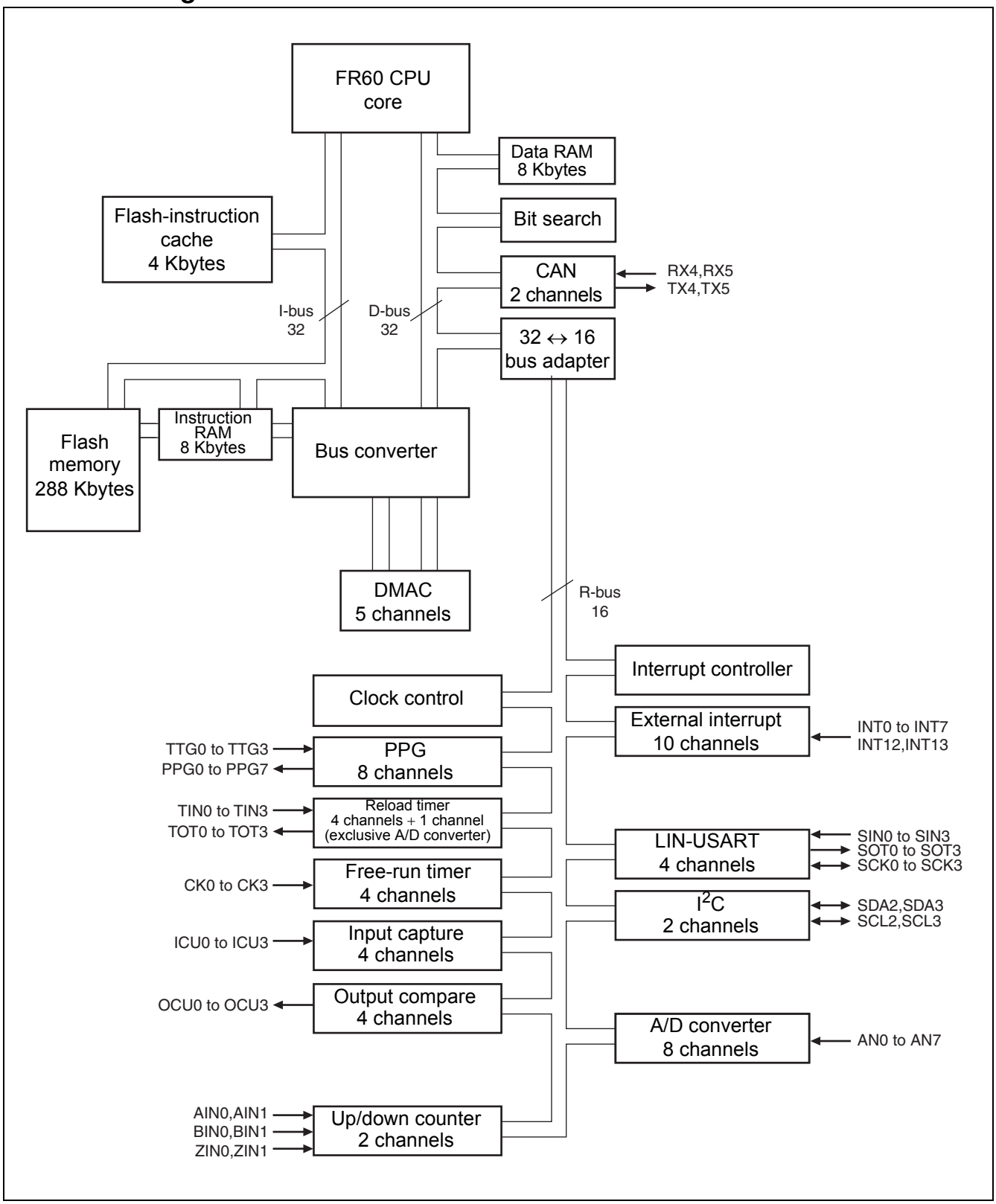
It may cause malfunctions if a stack pointer exists in the area which is set as the DSU operand break. Do not set the access to the areas containing the address of system stack pointer as a target of data event break.

7.4 Notes on PS Register

As the PS register is processed in advance by some instructions, when the debugger is being used, the following exception handling may result in execution breaking in an interrupt handling routine or the displayed values of the flags in the PS register being updated.As the microcontroller is designed to carry out reprocessing correctly upon returning from such an EIT event,the operation before and after the EIT always proceeds according to specification.

- The following behavior may occur if any of the following occurs in the instruction immediately after a DIV0U/DIV0S instruction: (a) a user interrupt or NMI is accepted; (b) single-step execution is performed; or (c) execution breaks due to a data event or from the emulator menu.
  - -D0 and D1 flags are updated in advance.
  - -An EIT handling routine (user interrupt/NMI or emulator) is executed.
  - -Upon returning from the EIT, the DIV0U/DIV0S instruction is executed and the D0 and D1 flags are updated to the same values as those in 1).
- The following behavior occurs when an ORCCR, STILM, MOV Ri or PS instruction is executed to enable a user interrupt or NMI source while that interrupt is in the active state.
  - -The PS register is updated in advance.
  - -An EIT handling routine (user interrupt/NMI or emulator) is executed.
  - -Upon returning from the EIT, the above instructions are executed and the PS register is updated to the same value as in 1).

8. Block Diagram



9. CPU and Control Unit

Internal Architecture

The FR family CPU is a high performance core that is designed based on the RISC architecture with advanced instructions for embedded applications.

9.1 Features

■ Adoption of RISC architecture
Basic instruction: 1 instruction per cycle

■ General-purpose registers: 32-bit × 16 registers

■ 4 Gbytes linear memory space

■ Multiplier installed
32-bit × 32-bit multiplication: 5 cycles
16-bit × 16-bit multiplication: 3 cycles

■ Enhanced interrupt processing function
Quick response speed (6 cycles)
Multiple-interrupt support
Level mask function (16 levels)

■ Enhanced instructions for I/O operation
Memory-to-memory transfer instruction
Bit processing instruction

■ Basic instruction word length: 16 bits

■ Low-power consumption
SLEEP mode/STOP mode

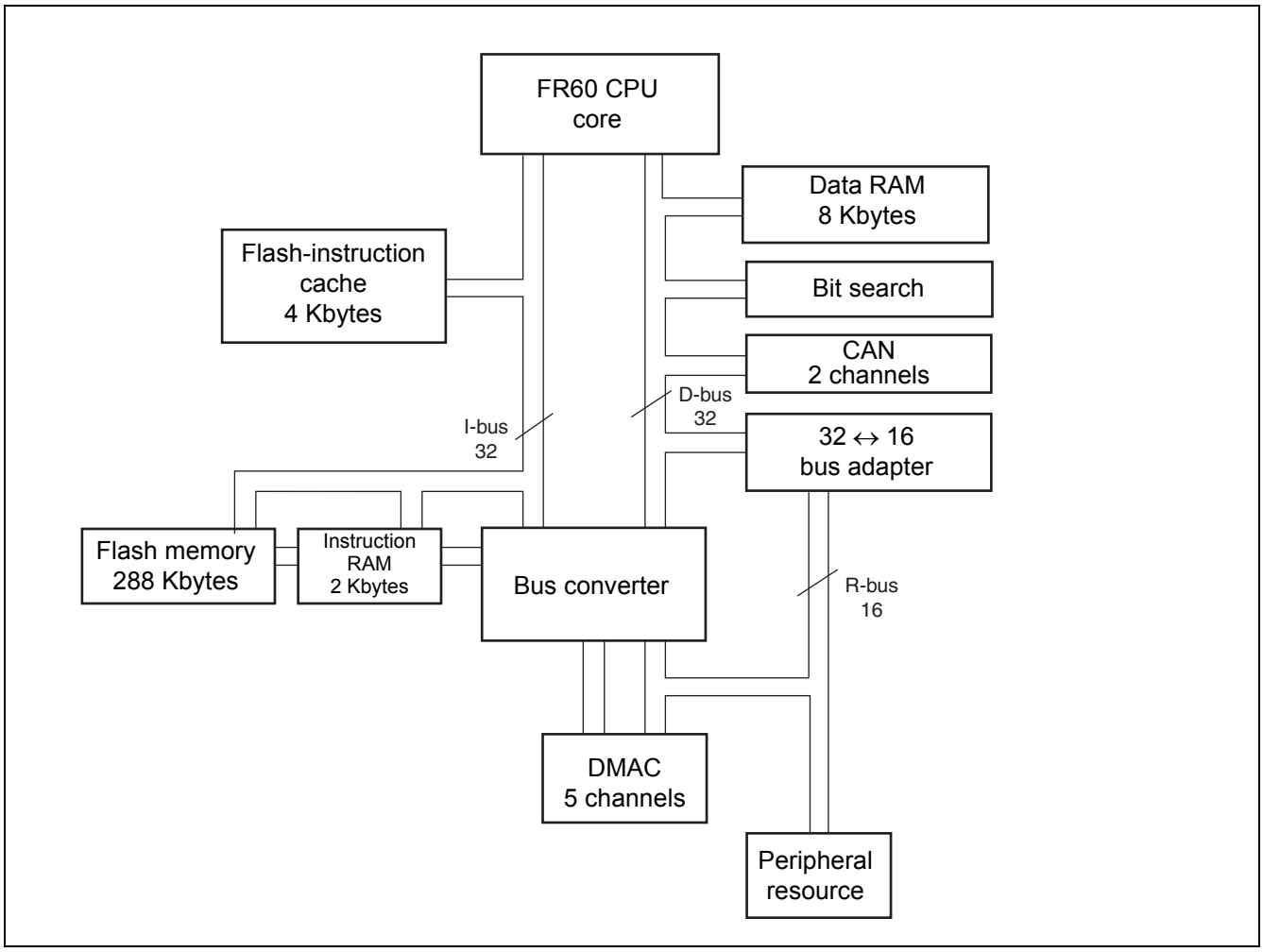
9.2 Internal Architecture

The FR family CPU uses the Harvard architecture in which the instruction bus and data bus are independent of each other.

A 32-bit ↔ 16-bit bus adapter is connected to the 32-bit bus (D-bus) to provide an interface between the CPU and peripheral resources.

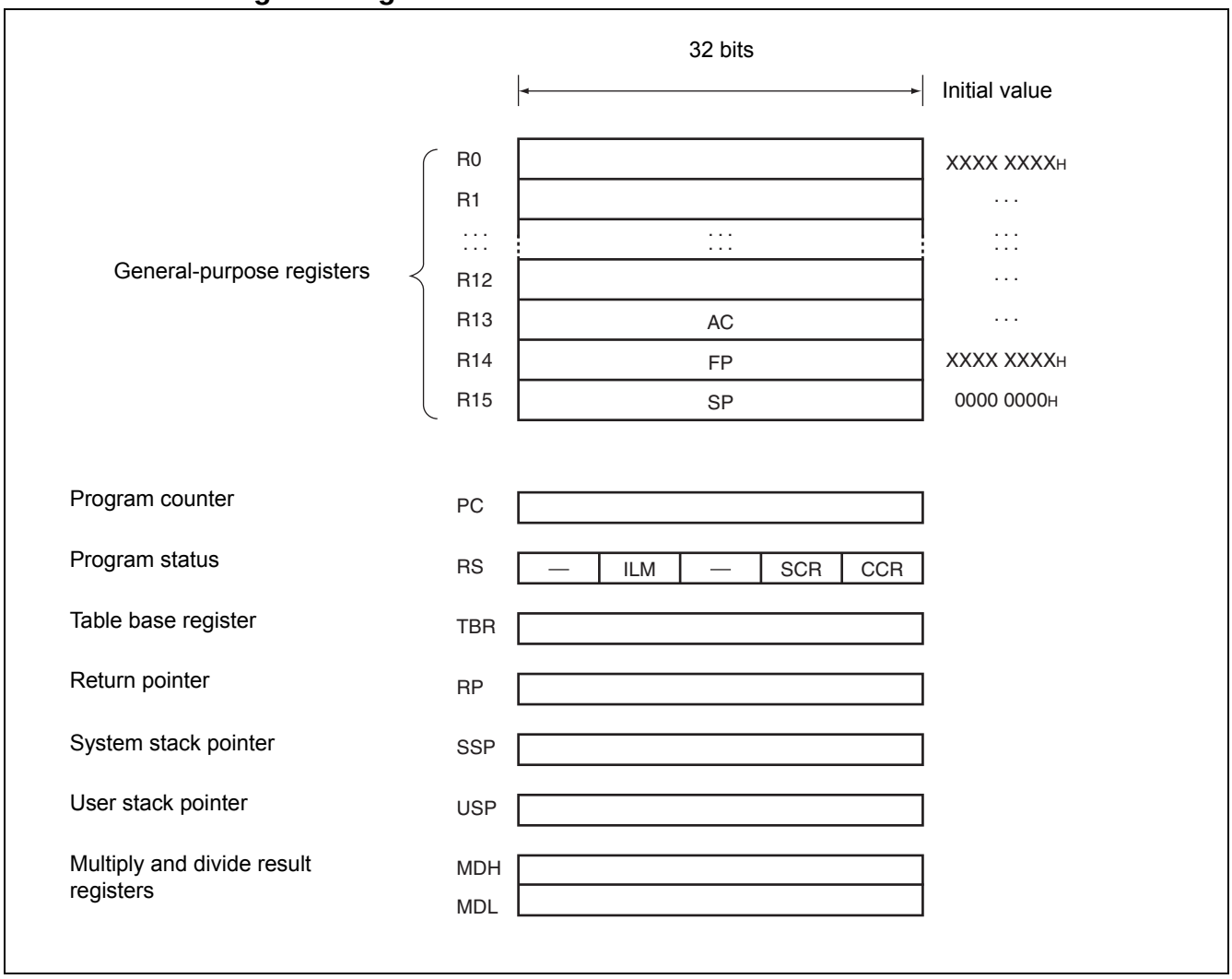
A Harvard ↔ Princeton bus converter is connected to both the I-bus and D-bus to provide an interface between the CPU and the bus controller.

The following figure shows the internal architecture structure.



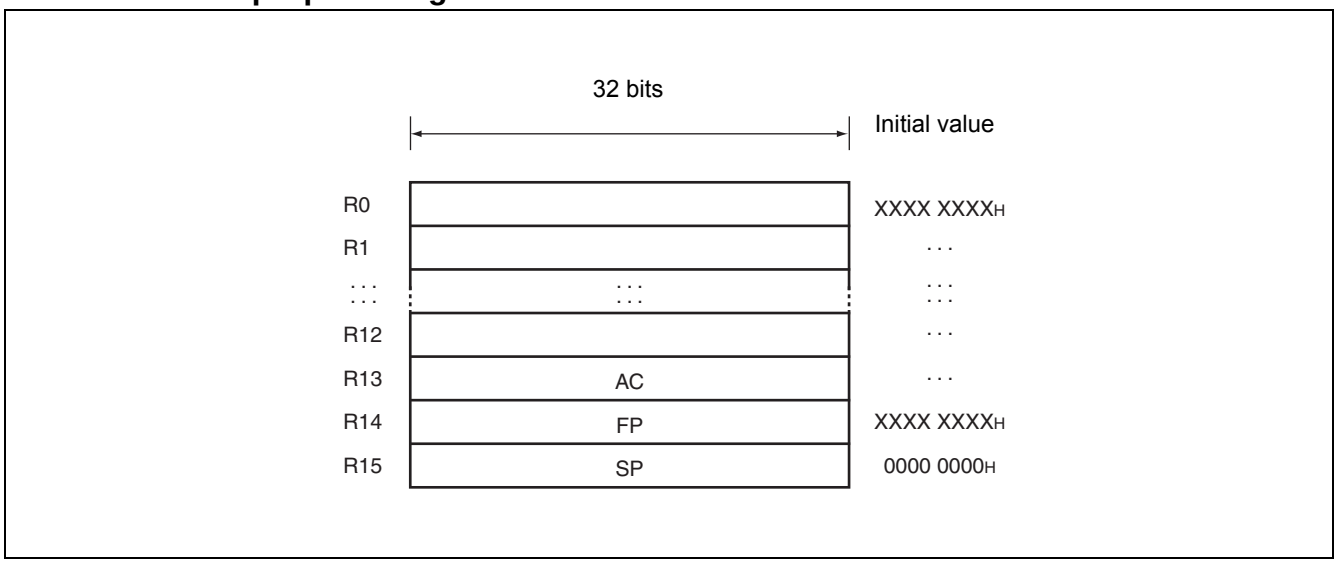
9.3 Programming Model

9.3.1 Basic Programming Model



9.4 Registers

9.4.1 General-purpose Register



Registers R0 to R15 are general-purpose registers. These registers can be used as accumulators for computation operations and as pointers for memory access.

Enhanced commands are provided for some of the 16 registers to enable their use for particular applications.

R13 : Virtual accumulator

R14 : Frame pointer

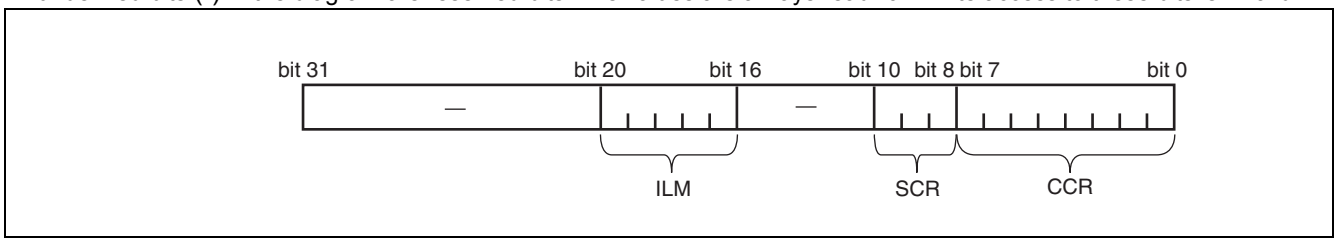
R15 : Stack pointer

Initial values at reset are undefined for R0 to R14. The value for R15 is 00000000_H (SSP value).

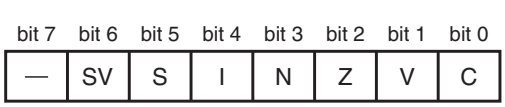
9.4.2 PS (Program Status)

This register holds the program status, and is divided into three parts, ILM, SCR, and CCR.

All undefined bits (-) in the diagram are reserved bits. The values are always read "0". Write access to these bits is invalid.



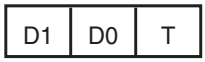
9.4.3 CCR (Condition Code Register)



Initial value
- 000XXXX$_B$

SV: Supervisor
S: Stack flag
I: Interrupt enable flag
N: Negative enable flag
Z: Zero flag
V: Overflow flag
C: Carry flag

9.4.4 SCR (System Condition Register)

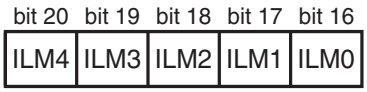


Initial value
XX0$_B$

Flag for step multiplication (D1, D0)
This flag stores interim data during execution of step multiplication.

Step trace trap flag (T)
This flag indicates whether the step trace trap is enabled or disabled.
The step trace trap function is used by emulators. When an emulator is in use, it cannot be used in execution of user programs.

9.4.5 ILM (Interrupt Level Mask Register)

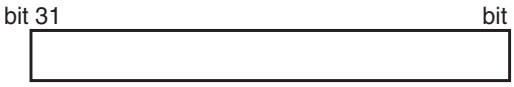


Initial value
01111$_B$

This register stores interrupt level mask values, and the values stored in ILM4 to ILM0 are used for level masking.

The register is initialized to value "01111_B" at reset.

9.4.6 PC (Program Counter)

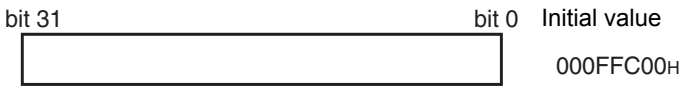


Initial value
XXXXXXXX$_H$

The program counter indicates the address of the instruction that is being executed.

The initial value at reset is undefined.

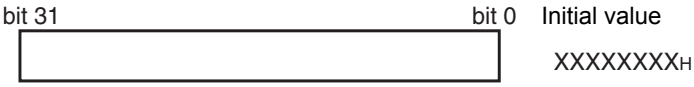
9.4.7 TBR (Table Base Register)



The table base register stores the starting address of the vector table used in EIT processing.

The initial value at reset is $000FFC00_H$.

9.4.8 RP (Return Pointer)



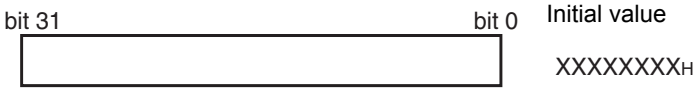
The return pointer stores the address to return from subroutines.

During execution of a CALL instruction, the PC value is transferred to this RP register.

During execution of a RET instruction, the contents of the RP register are transferred to PC.

The initial value at reset is undefined.

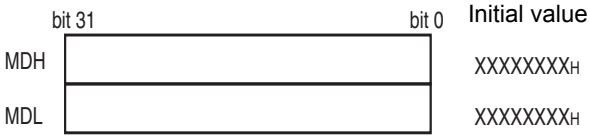
9.4.9 USP (User Stack Pointer)



When the S flag is “1”, the user stack pointer functions as the R15 register.

- The USP register can also be explicitly specified.
  The initial value at reset is undefined.
- This register cannot be used with RETI instructions.

9.4.10 Multiply & Divide Registers



These registers are for multiplication and division, and are each 32 bits in length.

The initial value at reset is undefined.

10. Mode Setting

In the FR family, the mode pins (MD2, MD1, MD0) and the mode register (MODR) are used to set the operating mode.

10.1 Mode Pins

The three pins MD2, MD1, MD0 are used to specify the mode vector fetch.

Settings other than shown in the table are prohibited.

Mode Pins[1]			Mode Name	Reset Vector Access Area	Remarks
MD2	MD1	MD0			
0	0	0	Internal ROM mode vector	Internal	
0	0	1	External ROM mode vector	External	Not allowed

1. Always use MD3 with “0”.

10.2 Mode Register (MODR)

The data written to the mode register using mode vector fetch is called mode data.

After the mode register (MODR) is set, the device operates according to the operation mode set in this register.

The mode register is set by all reset sources. User programs cannot write data to the mode register.

Rewriting is allowed in the emulator mode. In this case, use an 8-bit length data transfer instruction.

Data cannot be written by the transfer instruction of the 16/32-bit length.

Be sure to set these bits to “00000111_B”.

Operation is not guaranteed when any value other than “00000111_B” is set.

Note: The mode data needs to be allocated in $000FFFF8_H$ as byte data. The mode data (00000111_B) must be allocated in bit 31 to bit 24, as the FR family uses the big endian architecture.

11. Recommended Setting

11.1 Setting of PLL and Clock Gear

Table 1. Recommended Setting of PLL Division and Clock Gear

Clock Input [MHz]	PLL Multiplied Setting		Clock Gear Setting		PLL (vco) Output (X) [MHz]	Base Clock [MHz]
	DIVM	DIVN	DIVG	MULG		
4	2	20	16	20	160	80
4	2	19	16	20	152	76
4	2	18	16	20	144	72
4	2	17	16	16	136	68
4	2	16	16	16	128	64
4	2	15	16	16	120	60
4	2	14	16	16	112	56
4	2	13	16	12	104	52
4	2	12	16	12	96	48
4	2	11	16	12	88	44
4	4	10	16	24	160	40
4	4	9	16	24	144	36
4	4	8	16	24	128	32
4	4	7	16	24	112	28
4	6	6	16	24	144	24
4	8	5	16	28	160	20
4	10	4	16	32	160	16
4	12	3	16	32	144	12

11.2 Setting of Flash Memory Controller

11.2.1 Setting of Flash Access Timing

For executing programs with a Flash memory, follow the settings below according to the frequency of CPU clock (CLKB). This setting is the most suitable for a high-speed access to the Flash memory.

Table 2. Flash Memory Read Operating

CPU Clock (CLKB)	ATD	ALEH	EQ	WEXH	WTC
To 24 MHz	0	0	0	0	1
To 48 MHz	0	0	1	0	2
To 80 MHz	1	1	3	0	4

Table 3. Flash Memory Write Operating

CPU Clock (CLKB)	ATD	ALEH	EQ	WEXH	WTC
To 32 MHz	1	0	1	0	4
To 48 MHz	1	0	3	0	5
To 64 MHz	1	1	3	0	6
To 80 MHz	1	1	3	0	7

11.3 Setting of Clock Modulator

The setting values in the table are defined within the rages of base clock frequency; 32 MHz to 80 MHz. The Flash memory access needs to be configured according to the Fmax. PLL and clock gear need to be configured according to the base clock.

Table 4. Setting of Clock Modulator

Modulation (k)	Internal Parameter (N)	CMPR [hex]	Base Clock [MHz]	Fmin [MHz]	Fmax [MHz]
1	3	026F	80	72.6	89.1
1	3	026F	76	69.1	84.5
1	5	02AE	76	65.3	90.8
2	3	046E	76	65.3	90.8
1	3	026F	72	65.5	79.9
1	5	02AE	72	62	85.8
1	7	02ED	72	58.8	92.7
2	3	046E	72	62	85.8
1	3	026F	68	62	75.3
1	5	02AE	68	58.7	80.9
1	7	02ED	68	55.7	87.3
1	9	032C	68	53	95
2	3	046E	68	58.7	80.9
2	5	04AC	68	53	95
3	3	066D	68	55.7	87.3
4	3	086C	68	53	95
1	3	026F	64	58.5	70.7
1	5	02AE	64	55.3	75.9
1	7	02ED	64	52.5	82
1	9	032C	64	49.9	89.1
2	3	046E	64	55.3	75.9
2	5	04AC	64	49.9	89.1
3	3	066D	64	52.5	82
4	3	086C	64	49.9	89.1
1	3	026F	60	54.9	66.1
1	5	02AE	60	51.9	71
1	7	02ED	60	49.3	76.7
1	9	032C	60	46.9	83.3
2	3	046E	60	51.9	71
2	5	04AC	60	46.9	83.3
3	3	066D	60	49.3	76.7
4	3	086C	60	46.9	83.3
5	3	0A6B	60	44.7	91.3
1	3	026F	56	51.4	61.6
1	5	02AE	56	48.6	66.1
1	7	02ED	56	46.1	71.4
1	9	032C	56	43.8	77.6

Modulation (k)	Internal Parameter (N)	CMPR [hex]	Base Clock [MHz]	Fmin [MHz]	Fmax [MHz]
1	11	036B	56	41.8	84.9
1	13	03AA	56	39.9	93.8
2	3	046E	56	48.6	66.1
2	5	04AC	56	43.8	77.6
2	7	04EA	56	39.9	93.8
3	3	066D	56	46.1	71.4
4	3	086C	56	43.8	77.6
5	3	0A6B	56	41.8	84.9
1	3	026F	52	47.8	57
1	5	02AE	52	45.2	61.2
1	7	02ED	52	42.9	66.1
1	9	032C	52	40.8	71.8
1	11	036B	52	38.8	78.6
1	13	03AA	52	37.1	86.8
2	3	046E	52	45.2	61.2
2	5	04AC	52	40.8	71.8
2	7	04EA	52	37.1	86.8
3	3	066D	52	42.9	66.1
3	5	06AA	52	37.1	86.8
4	3	086C	52	40.8	71.8
5	3	0A6B	52	38.8	78.6
6	3	0C6A	52	37.1	86.8
1	3	026F	48	44.2	52.5
1	5	02AE	48	41.8	56.4
1	7	02ED	48	39.6	60.9
1	9	032C	48	37.7	66.1
1	11	036B	48	35.9	72.3
1	13	03AA	48	34.3	79.9
1	15	03E9	48	32.8	89.1
2	3	046E	48	41.8	56.4
2	5	04AC	48	37.7	66.1
2	7	04EA	48	34.3	79.9
3	3	066D	48	39.6	60.9
3	5	06AA	48	34.3	79.9
4	3	086C	48	37.7	66.1
5	3	0A6B	48	35.9	72.3
6	3	0C6A	48	34.3	79.9
7	3	0E69	48	32.8	89.1
1	3	026F	44	40.6	48.1
1	5	02AE	44	38.4	51.6
1	7	02ED	44	36.4	55.7

Modulation (k)	Internal Parameter (N)	CMPR [hex]	Base Clock [MHz]	Fmin [MHz]	Fmax [MHz]
1	9	032C	44	34.6	60.4
1	11	036B	44	33	66.1
1	13	03AA	44	31.5	73
1	15	03E9	44	30.1	81.4
2	3	046E	44	38.4	51.6
2	5	04AC	44	34.6	60.4
2	7	04EA	44	31.5	73
3	3	066D	44	36.4	55.7
3	5	06AA	44	31.5	73
4	3	086C	44	34.6	60.4
4	5	08A8	44	28.9	92.1
5	3	0A6B	44	33	66.1
6	3	0C6A	44	31.5	73
7	3	0E69	44	30.1	81.4
1	3	026F	40	37	43.6
1	5	02AE	40	34.9	46.8
1	7	02ED	40	33.1	50.5
1	9	032C	40	31.5	54.8
1	11	036B	40	30	59.9
1	13	03AA	40	28.7	66.1
1	15	03E9	40	27.4	73.7
2	3	046E	40	34.9	46.8
2	5	04AC	40	31.5	54.8
2	7	04EA	40	28.7	66.1
2	9	0528	40	26.3	83.3
3	3	066D	40	33.1	50.5
3	5	06AA	40	28.7	66.1
3	7	06E7	40	25.3	95.8
4	3	086C	40	31.5	54.8
4	5	08A8	40	26.3	83.3
5	3	0A6B	40	30	59.9
6	3	0C6A	40	28.7	66.1
7	3	0E69	40	27.4	73.7
8	3	1068	40	26.3	83.3
1	3	026F	36	33.3	39.2
1	5	02AE	36	31.5	42
1	7	02ED	36	29.9	45.3
1	9	032C	36	28.4	49.2
1	11	036B	36	27.1	53.8
1	13	03AA	36	25.8	59.3
1	15	03E9	36	24.7	66.1

Modulation (k)	Internal Parameter (N)	CMPR [hex]	Base Clock [MHz]	Fmin [MHz]	Fmax [MHz]
2	3	046E	36	31.5	42
2	5	04AC	36	28.4	49.2
2	7	04EA	36	25.8	59.3
2	9	0528	36	23.7	74.7
3	3	066D	36	29.9	45.3
3	5	06AA	36	25.8	59.3
3	7	06E7	36	22.8	85.8
4	3	086C	36	28.4	49.2
4	5	08A8	36	23.7	74.7
5	3	0A6B	36	27.1	53.8
6	3	0C6A	36	25.8	59.3
7	3	0E69	36	24.7	66.1
8	3	1068	36	23.7	74.7
9	3	1267	36	22.8	85.8
1	3	026F	32	29.7	34.7
1	5	02AE	32	28	37.3
1	7	02ED	32	26.6	40.2
1	9	032C	32	25.3	43.6
1	11	036B	32	24.1	47.7
1	13	03AA	32	23	52.5
1	15	03E9	32	22	58.6
2	3	046E	32	28	37.3
2	5	04AC	32	25.3	43.6
2	7	04EA	32	23	52.5
2	9	0528	32	21.1	66.1
2	11	0566	32	19.5	89.1
3	3	066D	32	26.6	40.2
3	5	06AA	32	23	52.5
3	7	06E7	32	20.3	75.9
4	3	086C	32	25.3	43.6
4	5	08A8	32	21.1	66.1
5	3	0A6B	32	24.1	47.7
5	5	0AA6	32	19.5	89.1
6	3	0C6A	32	23	52.5
7	3	0E69	32	22	58.6
8	3	1068	32	21.1	66.1
9	3	1267	32	20.3	75.9
10	3	1466	32	19.5	89.1

12. Memory Space

12.1 Memory space

The FR family has 4 Gbytes of logical address space (2^{32} addresses) available to the CPU by linear access.

■ Direct addressing area

The following address space area is used for I/O.

This area is called direct addressing area, and the address of an operand can be specified directly in an instruction.

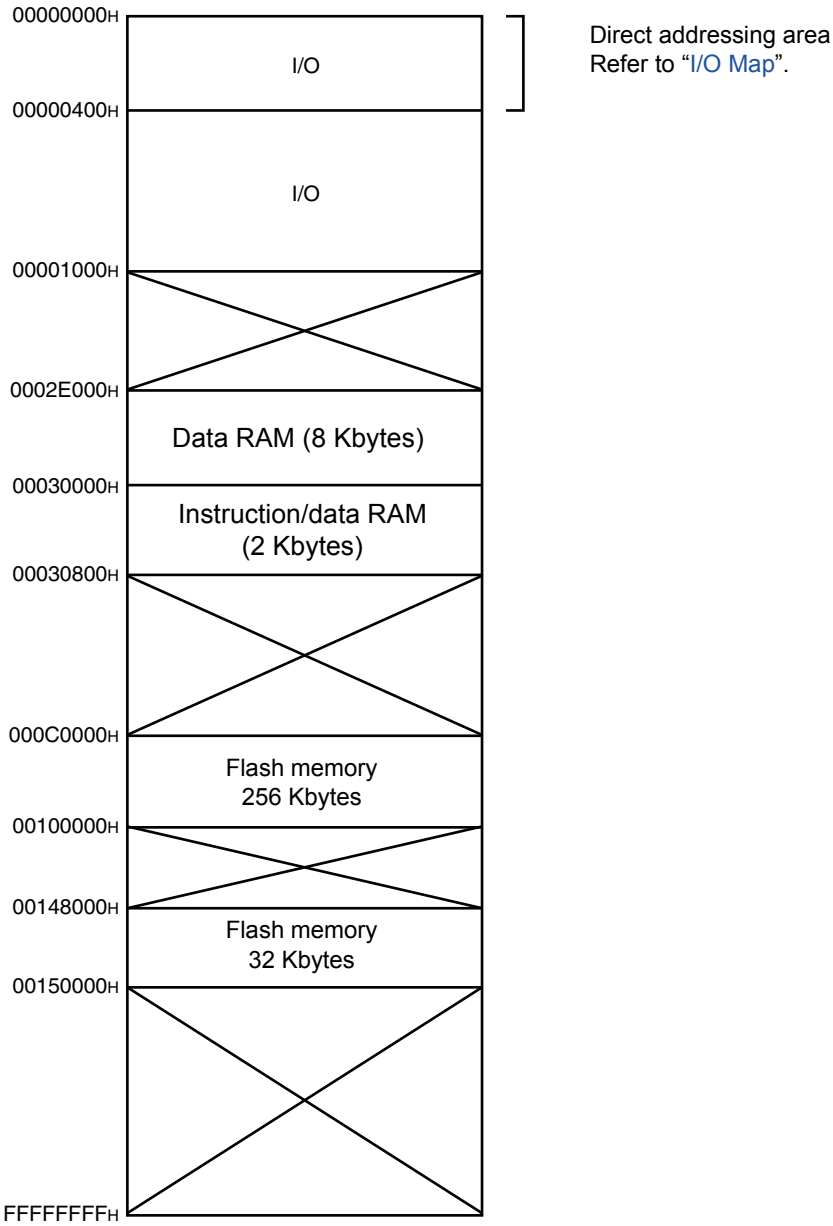
The size of directly addressable area depends on the length of the data to be accessed as shown below.

Byte data access: 000_H to $0FF_H$

Half word access: 000_H to $1FF_H$

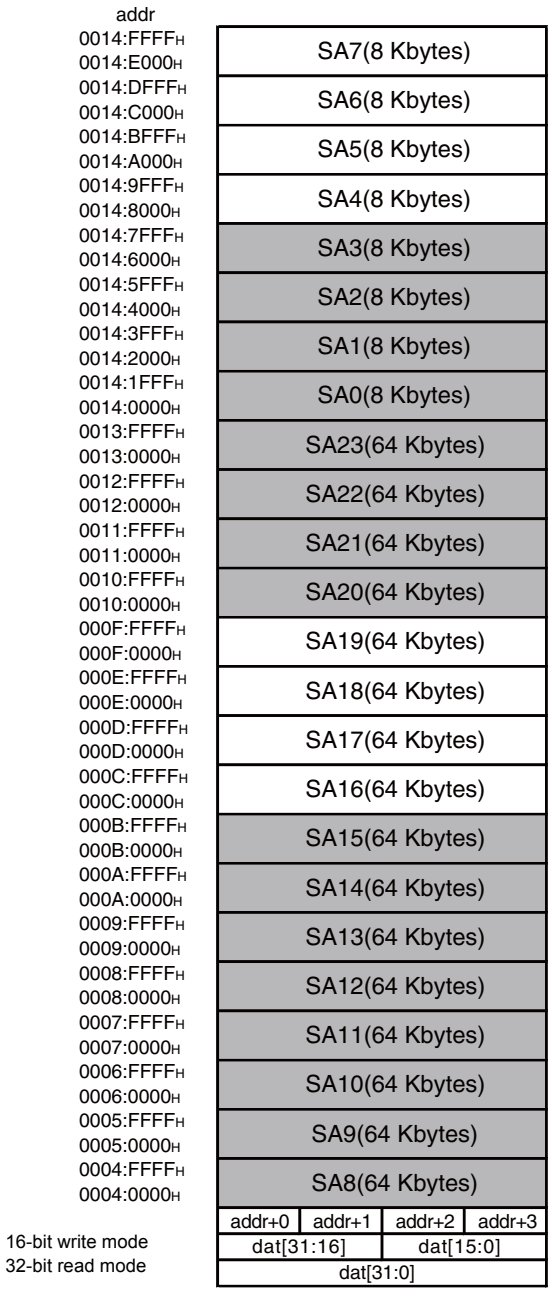
Word data access: 000_H to $3FF_H$

12.2 Memory Map



12.3 Flash Memory Sector Configuration

CY91F463NC

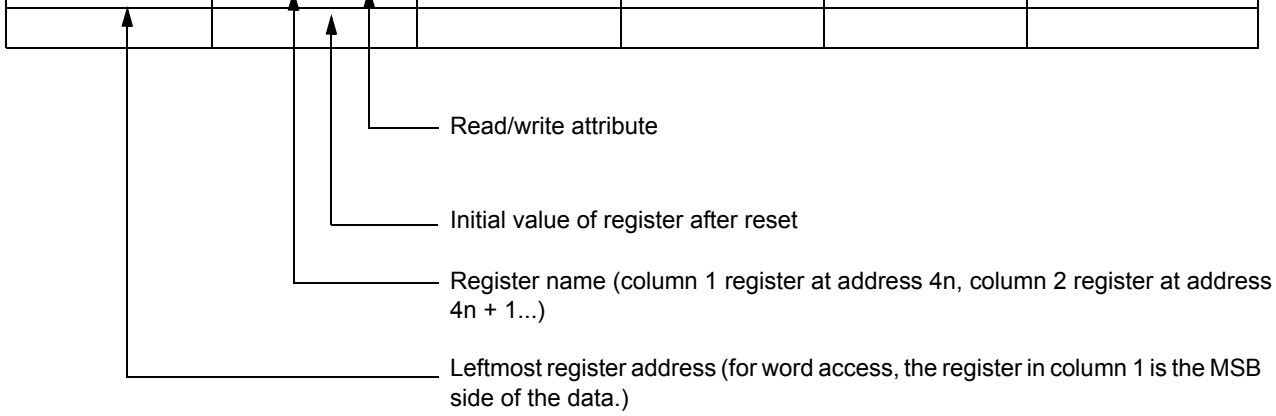


The shaded area is unusable.

Note: CY91F463NC has a different sector map for the flash memory to that of CY91F463NA. The sector map showed above is suited for CY91F463NC, not for CY91F463NA.

13. I/O Map

Address	Register				Block
	+ 0	+ 1	+ 2	+ 3	
000000_H	PDR0 [R/W] XXXXXXXX	PDR1 [R/W] XXXXXXXX	PDR2 [R/W] XXXXXXXX	PDR3 [R/W] XXXXXXXX	T-unit port data register



Note: Initial values of register bits are represented as follows:
" 1 ": Initial value " 1 "
" 0 ": Initial value " 0 "
" X ": Initial value " undefined "
" - ": No physical register at this location
Access is prohibited to areas where the data access attributes are undefined.

Address	Register				Block
	+0	+1	+2	+3	
000000_H to 000008_H	Reserved				R-bus Port Data Register
$00000C_H$	Reserved		PDR14 [R/W] - - - - XXXX	PDR15 [R/W] - - - - XXXX	
000010_H	Reserved	PDR17 [R/W] XXXXXXXX	Reserved		
000014_H	PDR20 [R/W] -XXX-XXX	PDR21 [R/W] -XXX-XXX	PDR22 [R/W] - - - - XXXX	Reserved	
000018_H	PDR24 [R/W] XXXXXXXX	Reserved			
$00001C_H$	Reserved	PDR29 [R/W] XXXXXXXX	Reserved		
000020_H	Reserved				
000024_H to $00002C_H$	Reserved				Reserved
000030_H	EIRR0 [R/W] 00000000	ENIR0 [R/W] 00000000	ELVR0 [R/W] 00000000 00000000		External interrupt 0 to 7
000034_H	EIRR1 [R/W] 00000000	ENIR1 [R/W] 00000000	ELVR1 [R/W] 00000000 00000000		External interrupt 12, 13
000038_H	DICR [R/W] - - - - - - - 0	HRCL [R/W] 0 - - 11111	Reserved		DLYI/I-unit
$00003C_H$	Reserved				Reserved
000040_H	SCR00 [R/W, W] 00000000	SMR00 [R/W, W] 00000000	SSR00 [R/W, R] 00001000	RDR00/TDR00 [R/W] 00000000	LIN-USART0
000044_H	ESCR00 [R/W] 00000X00	ECCR00 [R/W, R, W] 000000XX	Reserved		
000048_H	SCR01 [R/W, W] 00000000	SMR01 [R/W, W] 00000000	SSR01 [R/W, R] 00001000	RDR01/TDR01 [R/W] 00000000	LIN-USART1
$00004C_H$	ESCR01 [R/W] 00000X00	ECCR01 [R/W, R, W] 000000XX	Reserved		
000050_H	SCR02 [R/W, W] 00000000	SMR02 [R/W, W] 00000000	SSR02 [R/W, R] 00001000	RDR02/TDR02 [R/W] 00000000	LIN-USART2
000054_H	ESCR02 [R/W] 00000X00	ECCR02 [R/W, R, W] 000000XX	Reserved		
000058_H	SCR03 [R/W, W] 00000000	SMR03 [R/W, W] 00000000	SSR03 [R/W, R] 00001000	RDR03/TDR03 [R/W] 00000000	LIN-USART3
$00005C_H$	ESCR03 [R/W] 00000X00	ECCR03 [R/W, R, W] 000000XX	Reserved		

Address	Register				Block
	+0	+1	+2	+3	
000060_H to $00007C_H$	Reserved				Reserved
000080_H	BGR100 [R/W] 00000000	BGR000 [R/W] 00000000	BGR101 [R/W] 00000000	BGR001 [R/W] 00000000	Baud rate Generator LIN-USART0 to 3
000084_H	BGR102 [R/W] 00000000	BGR002 [R/W] 00000000	BGR103 [R/W] 00000000	BGR003 [R/W] 00000000	
000088_H, $00008C_H$	Reserved				
000090_H to $0000FC_H$	Reserved				Reserved
000100_H	GCN10 [R/W] 00110010 00010000		Reserved	GCN20 [R/W] - - - - 0000	PPG Control 0 to 3
000104_H	GCN11 [R/W] 00110010 00010000		Reserved	GCN21 [R/W] - - - - 0000	PPG Control 4 to 7
000108_H	Reserved				Reserved
000110_H	PTMR00 [R] 11111111 11111111		PCSR00 [W] XXXXXXXX XXXXXXXX		PPG 0
000114_H	PDUT00 [W] XXXXXXXX XXXXXXXX		PCNH00 [R/W] 0000000 -	PCNL00 [R/W] 000000 - 0	
000118_H	PTMR01 [R] 11111111 11111111		PCSR01 [W] XXXXXXXX XXXXXXXX		PPG 1
$00011C_H$	PDUT01 [W] XXXXXXXX XXXXXXXX		PCNH01 [R/W] 0000000 -	PCNL01 [R/W] 000000 - 0	
000120_H	PTMR02 [R] 11111111 11111111		PCSR02 [W] XXXXXXXX XXXXXXXX		PPG 2
000124_H	PDUT02 [W] XXXXXXXX XXXXXXXX		PCNH02 [R/W] 0000000 -	PCNL02 [R/W] 000000 - 0	
000128_H	PTMR03 [R] 11111111 11111111		PCSR03 [W] XXXXXXXX XXXXXXXX		PPG 3
$00012C_H$	PDUT03 [W] XXXXXXXX XXXXXXXX		PCNH03 [R/W] 0000000 -	PCNL03 [R/W] 000000 - 0	
000130_H	PTMR04 [R] 11111111 11111111		PCSR04 [W] XXXXXXXX XXXXXXXX		PPG 4
000134_H	PDUT04 [W] XXXXXXXX XXXXXXXX		PCNH04 [R/W] 0000000 -	PCNL04 [R/W] 000000 - 0	
000138_H	PTMR05 [R] 11111111 11111111		PCSR05 [W] XXXXXXXX XXXXXXXX		PPG 5
$00013C_H$	PDUT05 [W] XXXXXXXX XXXXXXXX		PCNH05 [R/W] 0000000 -	PCNL05 [R/W] 000000 - 0	
000140_H	PTMR06 [R] 11111111 11111111		PCSR06 [W] XXXXXXXX XXXXXXXX		PPG 6
000144_H	PDUT06 [W] XXXXXXXX XXXXXXXX		PCNH06 [R/W] 0000000 -	PCNL06 [R/W] 000000 - 0	
000148_H	PTMR07 [R] 11111111 11111111		PCSR07 [W] XXXXXXXX XXXXXXXX		PPG 7
$00014C_H$	PDUT07 [W] XXXXXXXX XXXXXXXX		PCNH07 [R/W] 0000000 -	PCNL07 [R/W] 000000 - 0	

Address	Register				Block
	+0	+1	+2	+3	
000150_H to $00017C_H$	Reserved				Reserved
000180_H	Reserved	ICS01 [R/W] 00000000	Reserved	ICS23 [R/W] 00000000	Input Capture 0 to 3
000184_H	IPCP0 [R] XXXXXXXX XXXXXXXX		IPCP1 [R] XXXXXXXX XXXXXXXX		
000188_H	IPCP2 [R] XXXXXXXX XXXXXXXX		IPCP3 [R] XXXXXXXX XXXXXXXX		
$00018C_H$	OCS01 [R/W] - - - 0 - - 00 0000 - - 00		OCS23 [R/W] - - - 0 - - 00 0000 - - 00		Output Compare 0 to 3
000190_H	OCCP0 [R/W] XXXXXXXX XXXXXXXX		OCCP1 [R/W] XXXXXXXX XXXXXXXX		
000194_H	OCCP2 [R/W] XXXXXXXX XXXXXXXX		OCCP3 [R/W] XXXXXXXX XXXXXXXX		
000198_H, $00019C_H$	Reserved				Reserved
$0001A0_H$	Reserved			ADERL [R/W] 00000000	A/D Converter
$0001A4_H$	ADCS1 [R/W] 00000000	ADCS0 [R/W] 00000000	ADCR1 [R] 000000XX	ADCR0 [R] XXXXXXXX	
$0001A8_H$	ADCT1 [R/W] 00010000	ADCT0 [R/W] 00101100	ADSCH [R/W] - - - 00000	ADECH [R/W] - - - 00000	
$0001AC_H$	Reserved				Reserved
$0001B0_H$	TMRLR0 [W] XXXXXXXX XXXXXXXX		TMR0 [R] XXXXXXXX XXXXXXXX		Reload Timer 0 (PPG0, PPG1)
$0001B4_H$	Reserved		TMCSRH0 [R/W] - - - 00000	TMCSRL0 [R/W] 0 - 000000	
$0001B8_H$	TMRLR1 [W] XXXXXXXX XXXXXXXX		TMR1 [R] XXXXXXXX XXXXXXXX		Reload Timer 1 (PPG2, PPG3)
$0001BC_H$	Reserved		TMCSRH1 [R/W] - - - 00000	TMCSRL1 [R/W] 0 - 000000	
$0001C0_H$	TMRLR2 [W] XXXXXXXX XXXXXXXX		TMR2 [R] XXXXXXXX XXXXXXXX		Reload Timer 2 (PPG4, PPG5)
$0001C4_H$	Reserved		TMCSRH2 [R/W] - - - 00000	TMCSRL2 [R/W] 0 - 000000	
$0001C8_H$	TMRLR3 [W] XXXXXXXX XXXXXXXX		TMR3 [R] XXXXXXXX XXXXXXXX		Reload Timer 3 (PPG6, PPG7)
$0001CC_H$	Reserved		TMCSRH3 [R/W] - - - 00000	TMCSRL3 [R/W] 0 - 000000	
$0001D0_H$ to $0001E7_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
$0001E8_H$	TMRLR7 [W] XXXXXXXX XXXXXXXX		TMR7 [R] XXXXXXXX XXXXXXXX		Reload Timer 7 (A/D converter)
$0001EC_H$	Reserved		TMCSRH7 [R/W] - - - 00000	TMCSRL7 [R/W] 0 - 000000	
$0001F0_H$	TCDT0 [R/W] XXXXXXXX XXXXXXXX		Reserved	TCCS0 [R/W] 00000000	Free-run Timer 0 (ICU0, ICU1)
$0001F4_H$	TCDT1 [R/W] XXXXXXXX XXXXXXXX		Reserved	TCCS1 [R/W] 00000000	Free-run Timer 1 (ICU2, ICU3)
$0001F8_H$	TCDT2 [R/W] XXXXXXXX XXXXXXXX		Reserved	TCCS2 [R/W] 00000000	Free-run Timer 2 (OCU0, OCU1)
$0001FC_H$	TCDT3 [R/W] XXXXXXXX XXXXXXXX		Reserved	TCCS3 [R/W] 00000000	Free-run Timer 3 (OCU2, OCU3)
000200_H	DMACA0 [R/W] * 00000000 0000XXXX XXXXXXXX XXXXXXXX				DMAC
000204_H	DMACB0 [R/W] 00000000 00000000 XXXXXXXX XXXXXXXX				
000208_H	DMACA1 [R/W] * 00000000 0000XXXX XXXXXXXX XXXXXXXX				
$00020C_H$	DMACB1 [R/W] 00000000 00000000 XXXXXXXX XXXXXXXX				
000210_H	DMACA2 [R/W] * 00000000 0000XXXX XXXXXXXX XXXXXXXX				
000214_H	DMACB2 [R/W] 00000000 00000000 XXXXXXXX XXXXXXXX				
000218_H	DMACA3 [R/W] * 00000000 0000XXXX XXXXXXXX XXXXXXXX				
$00021C_H$	DMACB3 [R/W] 00000000 00000000 XXXXXXXX XXXXXXXX				
000220_H	DMACA4 [R/W] * 00000000 0000XXXX XXXXXXXX XXXXXXXX				
000224_H	DMACB4 [R/W] 00000000 00000000 XXXXXXXX XXXXXXXX				
000228_H to $00023C_H$	Reserved				
000240_H	DMACR [R/W] 0- - - 0000	Reserved			
000244_H to $0002FC_H$	Reserved				Reserved
000300_H	UDRC1 [W] 00000000	UDRC0 [W] 00000000	UDCR1 [R] 00000000	UDCR0 [R] 00000000	Up/Down Counter 0, 1
000304_H	UDCCH0 [R/W] 00000000	UDCCL0 [R/W] 00001000	Reserved	UDCS0 [R/W] 00000000	
000308_H	UDCCH1 [R/W] 00000000	UDCCL1 [R/W] 00001000	Reserved	UDCS1 [R/W] 00000000	

Address	Register				Block
	+0	+1	+2	+3	
$00030C_H$ to 000364_H	Reserved				Reserved
000368_H	IBCR2 [R/W] 00000000	IBSR2 [R] 00000000	ITBAH2 [R/W] - - - - - - 00	ITBAL2 [R/W] 00000000	I^2C 2
$00036C_H$	ITMKH2 [R/W] 00 - - - - 11	ITMKL2 [R/W] 11111111	ISMK2 [R/W] 01111111	ISBA2 [R/W] - 0000000	
000370_H	Reserved	IDAR2 [R/W] 00000000	ICCR2 [R/W] - 0011111	Reserved	
000374_H	IBCR3 [R/W] 00000000	IBSR3 [R] 00000000	ITBAH3 [R/W] - - - - - - 00	ITBAL3 [R/W] 00000000	I^2C 3
000378_H	ITMKH3 [R/W] 00 - - - - 11	ITMKL3 [R/W] 11111111	ISMK3 [R/W] 01111111	ISBA3 [R/W] - 0000000	
$00037C_H$	Reserved	IDAR3 [R/W] 00000000	ICCR3 [R/W] - 0011111	Reserved	
000380_H to $00038C_H$	Reserved				Reserved
000390_H	ROMS [R] 11111111 01001111		Reserved		ROM Select Register
000394_H to $0003EC_H$	Reserved				Reserved
$0003F0_H$	BSD0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				Bit Search Module
$0003F4_H$	BSD1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0003F8_H$	BSDC [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0003FC_H$	BSRR [R] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000400_H to $00043C_H$	Reserved				Reserved
000440_H	ICR00 [R/W] - - - 11111	ICR01 [R/W] - - - 11111	ICR02 [R/W] - - - 11111	ICR03 [R/W] - - - 11111	Interrupt Control Unit
000444_H	ICR04[R/W] - - - 11111	ICR05 [R/W] - - - 11111	ICR06 [R/W] - - - 11111	ICR07 [R/W] - - - 11111	
000448_H	ICR08 [R/W] - - - 11111	ICR09 [R/W] - - - 11111	ICR10[R/W] - - - 11111	ICR11 [R/W] - - - 11111	
$00044C_H$	ICR12 [R/W] - - - 11111	ICR13[R/W] - - - 11111	ICR14[R/W] - - - 11111	ICR15[R/W] - - - 11111	
000450_H	ICR16[R/W] - - - 11111	ICR17[R/W] - - - 11111	ICR18 [R/W] - - - 11111	ICR19 [R/W] - - - 11111	

Address	Register				Block
	+0	+1	+2	+3	
000454_H	ICR20 [R/W] - - - 11111	ICR21 [R/W] - - - 11111	ICR22 [R/W] - - - 11111	ICR23 [R/W] - - - 11111	Interrupt Control Unit
000458_H	ICR24[R/W] - - - 11111	ICR25[R/W] - - - 11111	ICR26[R/W] - - - 11111	ICR27[R/W] - - - 11111	
$00045C_H$	ICR28[R/W] - - - 11111	ICR29 [R/W] - - - 11111	ICR30[R/W] - - - 11111	ICR31[R/W] - - - 11111	
000460_H	ICR32[R/W] - - - 11111	ICR33[R/W] - - - 11111	ICR34[R/W] - - - 11111	ICR35[R/W] - - - 11111	
000464_H	ICR36[R/W] - - - 11111	ICR37[R/W] - - - 11111	ICR38 [R/W] - - - 11111	ICR39 [R/W] - - - 11111	
000468_H	ICR40[R/W] - - - 11111	ICR41[R/W] - - - 11111	ICR42 [R/W] - - - 11111	ICR43 [R/W] - - - 11111	
$00046C_H$	ICR44[R/W] - - - 11111	ICR45[R/W] - - - 11111	ICR46[R/W] - - - 11111	ICR47[R/W] - - - 11111	
000470_H	ICR48 [R/W] - - - 11111	ICR49 [R/W] - - - 11111	ICR50 [R/W] - - - 11111	ICR51 [R/W] - - - 11111	
000474_H	ICR52[R/W] - - - 11111	ICR53[R/W] - - - 11111	ICR54[R/W] - - - 11111	ICR55[R/W] - - - 11111	
000478_H	ICR56 [R/W] - - - 11111	ICR57[R/W] - - - 11111	ICR58 [R/W] - - - 11111	ICR59 [R/W] - - - 11111	
$00047C_H$	ICR60[R/W] - - - 11111	ICR61 [R/W] - - - 11111	ICR62 [R/W] - - - 11111	ICR63 [R/W] - - - 11111	
000480_H	RSRR [R/W] 10000000	STCR [R/W] 001100-1	TBCR [R/W] 00XXXX00	CTBR [W] XXXXXXXX	Clock Control Unit
000484_H	CLKR [R/W] - - - - - 000	WPR [W] XXXXXXXX	DIVR0 [R/W] 00000011	DIVR1 [R/W] 00000000	
000488_H	Reserved				Reserved
$00048C_H$	PLLDIVM [R/W] - - - - 0000	PLLDIVN [R/W] - - 000000	PLLDIVG [R/W] - - - - 0000	PLLMULG [R/W] 00000000	PLL Clock Gear Unit
000490_H	PLLCTRL [R/W] - - - - 0000	Reserved			
000494_H	Reserved				Reserved
000498_H	PORTEN [R/W] - - - - - - 00	Reserved			Port Input Enable Control
$00049C_H$	Reserved				Reserved
$0004A0_H$	Reserved	WTCER [R/W] - - - - - - 00	WTCR [R/W] 00000000 000 - 00 - 0		Real Time Clock (Watch Timer)
$0004A4_H$	Reserved	WTBR [R/W] - - - XXXXX XXXXXXXX XXXXXXXX			
$0004A8_H$	WTHR [R/W] - - - 00000	WTMR [R/W] - - 000000	WTSR [R/W] - - 000000	Reserved	
$0004AC_H$	Reserved		CSCFG [R/W] 0X000000	CMCFG [R/W] 00000000	Clock Monitor
$0004B0_H$, $0004B4_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
$0004B8_H$	CMPR [R/W] - - 000010 11111101		Reserved	CMCR [R/W] - 001 - - 00	Clock Modulator
$0004BC_H$	CMT1 [R/W] 00000000 1 - - - 0000		CMT2 [R/W] - - 000000 - - 000000		
$0004C0_H$	CANPRE [R/W] 00000000	CANCKD [R/W] - - 00 - - - -	Reserved		CAN Clock Control
$0004C4_H$	Reserved	LVDET [R/W] 00000 - 00	HWWDE [R/W] - - - - - - 00	HWWD [R/W, W] 00011000	Low-voltage Detection
$0004C8_H$	OSCRH [R/W] 000 - - 001	OSCRL [R/W] - - - - - 000	Reserved		Main-Oscillation Stabilization Timer
$0004CC_H$	Reserved				
$0004D0_H$ to $0007F8_H$	Reserved				Reserved
$0007FC_H$	Reserved	MODR [W] XXXXXXXX	Reserved		Mode Register
000800_H to $000CFC_H$	Reserved				Reserved
$000D00_H$ to $000D08_H$	Reserved				R-bus Port Data Direct Read Register
$000D0C_H$	Reserved		PDRD14 [R] - - - - XXXX	PDRD15 [R] - - - - XXXX	
$000D10_H$	Reserved	PDRD17 [R] XXXXXXXX	Reserved		
$000D14_H$	PDRD20 [R] - XXX- XXX	PDRD21 [R] - XXX- XXX	PDRD22 [R] - - - - XXXX	Reserved	
$000D18_H$	PDRD24 [R] XXXXXXXX	Reserved			
$000D1C_H$	Reserved	PDRD29 [R] XXXXXXXX	Reserved		
$000D20_H$	Reserved				
$000D24_H$ to $000D3C_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
$000D40_H$ to $000D48_H$	Reserved				R-bus Port Direction Register
$000D4C_H$	Reserved		DDR14 [R/W] - - - - 0000	DDR15 [R/W] - - - - 0000	
$000D50_H$	Reserved	DDR17 [R/W] 00000000	Reserved		
$000D54_H$	DDR20 [R/W] -000- 000	DDR21 [R/W] -000- 000	DDR22 [R/W] - - - - 0000	Reserved	
$000D58_H$	DDR24 [R/W] 00000000	Reserved			
$000D5C_H$	Reserved	DDR29 [R/W] 00000000	Reserved		
$000D60_H$	Reserved				
$000D64_H$ to $000D7C_H$	Reserved				Reserved
$000D80_H$ to $000D88_H$	Reserved				R-bus Port Function Register
$000D8C_H$	Reserved		PFR14 [R/W] - - - - 0000	PFR15 [R/W] - - - - 0000	
$000D90_H$	Reserved	PFR17 [R/W] 00000000	Reserved		
$000D94_H$	PFR20 [R/W] -000- 000	PFR21 [R/W] -000- 000	PFR22 [R/W] - - - - 0000	Reserved	
$000D98_H$	PFR24 [R/W] 00000000	Reserved			
$000D9C_H$	Reserved	PFR29 [R/W] 00000000	Reserved		
$000DA0_H$	Reserved				
$000DA4_H$ to $000DBC_H$	Reserved				Reserved
$000DC0_H$ to $000DC8_H$	Reserved				R-bus Extension Port Function Register
$000DCC_H$	Reserved		EPFR14 [R/W] - - - - 0000	EPFR15 [R/W] - - - - 0000	
$000DD0_H$	Reserved				R-bus Extension Port Function Register
$000DD4_H$	EPFR20 [R/W] - 000- 000	EPFR21 [R/W] - 0- - - 0- -	Reserved		
$000DD8_H$	Reserved				
$000DDC_H$	Reserved				
$000DE0_H$	Reserved				
$000DE4_H$ to $000DFC_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
$000E00_H$ to $000E08_H$	Reserved				R-bus Port Output Drive Select Register
$000E0C_H$	Reserved		PODR14 [R/W] - - - - 0000	PODR15 [R/W] - - - - 0000	
$000E10_H$	Reserved	PODR17 [R/W] 00000000	Reserved		
$000E14_H$	PODR20 [R/W] - 000- 000	PODR21 [R/W] - 000- 000	PODR22 [R/W] - - - - 0000	Reserved	
$000E18_H$	PODR24 [R/W] 00000000	Reserved			
$000E1C_H$	Reserved	PODR29 [R/W] 00000000	Reserved		
$000E20_H$	Reserved				
$000E24_H$ to $000E3C_H$	Reserved				Reserved
$000E40_H$ to $000E48_H$	Reserved				R-bus Pin Input Level Select Register
$000E4C_H$	Reserved		PILR14 [R/W] - - - - 0000	PILR15 [R/W] - - - - 0000	
$000E50_H$	Reserved	PILR17 [R/W] 00000000	Reserved		
$000E54_H$	PILR20 [R/W] - 000- 000	PILR21 [R/W] -000- 000	PILR22 [R/W] - - - - 0000	Reserved	
$000E58_H$	PILR24 [R/W] 00000000	Reserved			
$000E5C_H$	Reserved	PILR29 [R/W] 00000000	Reserved		
$000E60_H$	Reserved				
$000E64_H$ to $000E7C_H$	Reserved				Reserved
$000E80_H$ to $000E88_H$	Reserved				R-bus Port Extra Input Level Select Register
$000E8C_H$	Reserved		EPILR14 [R/W] - - - - 0000	EPILR15 [R/W] - - - - 0000	
$000E90_H$	Reserved	EPILR17 [R/W] 00000000	Reserved		
$000E94_H$	EPILR20 [R/W] - 000- 000	EPILR21 [R/W] - 000- 000	EPILR22 [R/W] - - - - 0000	Reserved	
$000E98_H$	EPILR24 [R/W] 00000000	Reserved			
$000E9C_H$, $000EA0_H$	Reserved				

Address	Register				Block
	+0	+1	+2	+3	
$000EA4_H$ to $000EBC_H$	Reserved				Reserved
$000EC0_H$ to $000EC8_H$	Reserved				R-bus Port Pull-up/down Enable Register
$000ECC_H$	Reserved		PPER14 [R/W] - - - - 0000	PPER15 [R/W] - - - - 0000	
$000ED0_H$	Reserved	PPER17 [R/W] 00000000	Reserved		
$000ED4_H$	PPER20 [R/W] -000- 000	PPER21 [R/W] -000- 000	PPER22 [R/W] - - - - 0000	Reserved	
$000ED8_H$	PPER24 [R/W] 00000000	Reserved			
$000EDC_H$	Reserved	PPER29 [R/W] 00000000	Reserved		
$000EE0_H$	Reserved				
$000EE4_H$ to $000EFC_H$	Reserved				Reserved
$000F00_H$ to $000F08_H$	Reserved				R-bus Port Pull-up/down Control-Register
$000F0C_H$	Reserved		PPCR14 [R/W] - - - - 1111	PPCR15 [R/W] - - - - 1111	R-bus Port Pull-up/down Control Register
$000F10_H$	Reserved	PPCR17 [R/W] 11111111	Reserved		
$000F14_H$	PPCR20 [R/W] -111-111	PPCR21 [R/W] -111-111	PPCR22 [R/W] - - - - 1111	Reserved	
$000F18_H$	PPCR24 [R/W] 11111111	Reserved			
$000F1C_H$	Reserved	PPCR29 [R/W] 11111111	Reserved		
$000F20_H$	Reserved				
$000F24_H$ to $000F3C_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
001000_H	DMASA0 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				DMAC
001004_H	DMADA0 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001008_H	DMASA1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00100C_H$	DMADA1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001010_H	DMASA2 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001014_H	DMADA2 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001018_H	DMASA3 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00101C_H$	DMADA3 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001020_H	DMASA4 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001024_H	DMADA4 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
001028_H to $006FFC_H$	Reserved				Reserved
007000_H	FMCS [R/W] 01101000	FMCR [R/W] - - - -0000	FCHCR [R/W] - - - - - - 00 10000011		Flash Memory/ I-Cache Control Register
007004_H	FMWT [R/W] 11111111 01011101		FMWT2 [R/W] - 101 - - - -	FMPS [R/W] - - - - - 000	
007008_H	FMAC [R] - - - - - - - - - - - - 00000 00000000 00000000				
$00700C_H$	FCHA0 [R/W] - - - - - - - - - 0000000 00000000 00000000				I-Cache Non-cacheable area setting Register
007010_H	FCHA1 [R/W] - - - - - - - - - 0000000 00000000 00000000				
007014_H to $00AFFC_H$	Reserved				Reserved
$00B000_H$ to $00BFFC_H$	BI-ROM size is 4 Kbytes : $00B000_H$ to $00BFFF_H$				BI-ROM 4 Kbytes
$00C000_H$ to $00C3FC_H$	Reserved				Reserved

Address	Register				Block
	+0	+1	+2	+3	
$00C400_H$	CTRLR4 [R/W] 00000000 00000001		STATR4 [R/W] 00000000 00000000		CAN 4 Control Register
$00C404_H$	ERRCNT4 [R] 00000000 00000000		BTR4 [R/W] 00100011 00000001		
$00C408_H$	INTR4 [R] 00000000 00000000		TESTR4 [R/W] 00000000 X0000000		
$00C40C_H$	BRPE4 [R/W] 00000000 00000000		Reserved		
$00C410_H$	IF1CREQ4 [R/W] 00000000 00000001		IF1CMSK4 [R/W] 00000000 00000000		CAN 4 IF1 Register
$00C414_H$	IF1MSK24 [R/W] 11111111 11111111		IF1MSK14 [R/W] 11111111 11111111		
$00C418_H$	IF1ARB24 [R/W] 00000000 00000000		IF1ARB14 [R/W] 00000000 00000000		
$00C41C_H$	IF1MCTR4 [R/W] 00000000 00000000		Reserved		
$00C420_H$	IF1DTA14 [R/W] 00000000 00000000		IF1DTA24 [R/W] 00000000 00000000		
$00C424_H$	IF1DTB14 [R/W] 00000000 00000000		IF1DTB24 [R/W] 00000000 00000000		
$00C428_H$, $00C42C_H$	Reserved				
$00C430_H$	IF1DTA24 [R/W] 00000000 00000000		IF1DTA14 [R/W] 00000000 00000000		CAN 4 IF1 Register
$00C434_H$	IF1DTB24 [R/W] 00000000 00000000		IF1DTB14 [R/W] 00000000 00000000		
$00C438_H$, $00C43C_H$	Reserved				

Address	Register				Block
	+0	+1	+2	+3	
$00C440_H$	IF2CREQ4 [R/W] 00000000 00000001		IF2CMSK4 [R/W] 00000000 00000000		CAN 4 IF2 Register
$00C444_H$	IF2MSK24 [R/W] 11111111 11111111		IF2MSK14 [R/W] 11111111 11111111		
$00C448_H$	IF2ARB24 [R/W] 00000000 00000000		IF2ARB14 [R/W] 00000000 00000000		
$00C44C_H$	IF2MCTR4 [R/W] 00000000 00000000		Reserved		
$00C450_H$	IF2DTA14 [R/W] 00000000 00000000		IF2DTA24 [R/W] 00000000 00000000		
$00C454_H$	IF2DTB14 [R/W] 00000000 00000000		IF2DTB24 [R/W] 00000000 00000000		
$00C458_H$, $00C45C_H$	Reserved				
$00C460_H$	IF2DTA24 [R/W] 00000000 00000000		IF2DTA14 [R/W] 00000000 00000000		
$00C464_H$	IF2DTB24 [R/W] 00000000 00000000		IF2DTB14 [R/W] 00000000 00000000		
$00C468_H$ to $00C47C_H$	Reserved				
$00C480_H$	TREQR24 [R] 00000000 00000000		TREQR14 [R] 00000000 00000000		CAN 4 Status Flags
$00C484_H$	TREQR44 [R] 00000000 00000000		TREQR34 [R] 00000000 00000000		
$00C488_H$	TREQR64 [R] 00000000 00000000		TREQR54 [R] 00000000 00000000		
$00C48C_H$	TREQR84 [R] 00000000 00000000		TREQR74 [R] 00000000 00000000		
$00C490_H$	NEWDT24 [R] 00000000 00000000		NEWDT14 [R] 00000000 00000000		
$00C494_H$	NEWDT44 [R] 00000000 00000000		NEWDT34 [R] 00000000 00000000		

Address	Register				Block
	+0	+1	+2	+3	
$00C498_H$	NEWDT64 [R] 00000000 00000000		NEWDT54 [R] 00000000 00000000		CAN 4 Status Flags
$00C49C_H$	NEWDT84 [R] 00000000 00000000		NEWDT74 [R] 00000000 00000000		
$00C4A0_H$	INTPND24 [R] 00000000 00000000		INTPND14 [R] 00000000 00000000		
$00C4A4_H$	INTPND44 [R] 00000000 00000000		INTPND34 [R] 00000000 00000000		
$00C4A8_H$	INTPND64 [R] 00000000 00000000		INTPND54 [R] 00000000 00000000		
$00C4AC_H$	INTPND84 [R] 00000000 00000000		INTPND74 [R] 00000000 00000000		
$00C4B0_H$	MSGVAL24 [R] 00000000 00000000		MSGVAL14 [R] 00000000 00000000		
$00C4B4_H$	MSGVAL44 [R] 00000000 00000000		MSGVAL34 [R] 00000000 00000000		
$00C4B8_H$	MSGVAL64 [R] 00000000 00000000		MSGVAL54 [R] 00000000 00000000		
$00C4BC_H$	MSGVAL84 [R] 00000000 00000000		MSGVAL74 [R] 00000000 00000000		
$00C4C0_H$ to $00C4FC_H$	Reserved				
$00C500_H$	CTRLR5 [R/W] 00000000 00000001		STATR5 [R/W] 00000000 00000000		CAN 5 Control Register
$00C504_H$	ERRCNT5 [R] 00000000 00000000		BTR5 [R/W] 00100011 00000001		
$00C508_H$	INTR5 [R] 00000000 00000000		TESTR5 [R/W] 00000000 X0000000		
$00C50C_H$	BRPE5 [R/W] 00000000 00000000		Reserved		
$00C510_H$	IF1CREQ5 [R/W] 00000000 00000001		IF1CMSK5 [R/W] 00000000 00000000		CAN 5 IF1 Register
$00C514_H$	IF1MSK25 [R/W] 11111111 11111111		IF1MSK15 [R/W] 11111111 11111111		
$00C518_H$	IF1ARB25 [R/W] 00000000 00000000		IF1ARB15 [R/W] 00000000 00000000		
$00C51C_H$	IF1MCTR5 [R/W] 00000000 00000000		Reserved		
$00C520_H$	IF1DTA15 [R/W] 00000000 00000000		IF1DTA25 [R/W] 00000000 00000000		

Address	Register				Block
	+0	+1	+2	+3	
$00C524_H$	IF1DTB15 [R/W] 00000000 00000000		IF1DTB25 [R/W] 00000000 00000000		CAN 5 IF1 Register
$00C528_H$, $00C52C_H$	Reserved				
$00C530_H$	IF1DTA25 [R/W] 00000000 00000000		IF1DTA15 [R/W] 00000000 00000000		
$00C534_H$	IF1DTB25 [R/W] 00000000 00000000		IF1DTB15 [R/W] 00000000 00000000		
$00C538_H$, $00C53C_H$	Reserved				
$00C540_H$	IF2CREQ5 [R/W] 00000000 00000001		IF2CMSK5 [R/W] 00000000 00000000		CAN 5 IF2 Register
$00C544_H$	IF2MSK25 [R/W] 11111111 11111111		IF2MSK15 [R/W] 11111111 11111111		
$00C548_H$	IF2ARB25 [R/W] 00000000 00000000		IF2ARB15 [R/W] 00000000 00000000		
$00C54C_H$	IF2MCTR5 [R/W] 00000000 00000000		Reserved		
$00C550_H$	IF2DTA15 [R/W] 00000000 00000000		IF2DTA25 [R/W] 00000000 00000000		
$00C554_H$	IF2DTB15 [R/W] 00000000 00000000		IF2DTB25 [R/W] 00000000 00000000		
$00C558_H$, $00C55C_H$	Reserved				
$00C560_H$	IF2DTA25 [R/W] 00000000 00000000		IF2DTA15 [R/W] 00000000 00000000		
$00C564_H$	IF2DTB25 [R/W] 00000000 00000000		IF2DTB15 [R/W] 00000000 00000000		
$00C568_H$ to $00C57C_H$	Reserved				

Address	Register				Block
	+0	+1	+2	+3	
$00C580_H$	TREQR25 [R] 00000000 00000000		TREQR15 [R] 00000000 00000000		CAN 5 Status Flags
$00C584_H$	TREQR45 [R] 00000000 00000000		TREQR35 [R] 00000000 00000000		
$00C588_H$	TREQR65 [R] 00000000 00000000		TREQR55 [R] 00000000 00000000		
$00C58C_H$	TREQR85 [R] 00000000 00000000		TREQR75 [R] 00000000 00000000		
$00C590_H$	NEWDT25 [R] 00000000 00000000		NEWDT15 [R] 00000000 00000000		
$00C594_H$	NEWDT45 [R] 00000000 00000000		NEWDT35 [R] 00000000 00000000		
$00C598_H$	NEWDT65 [R] 00000000 00000000		NEWDT55 [R] 00000000 00000000		
$00C59C_H$	NEWDT85 [R] 00000000 00000000		NEWDT75 [R] 00000000 00000000		
$00C5A0_H$	INTPND25 [R] 00000000 00000000		INTPND15 [R] 00000000 00000000		
$00C5A4_H$	INTPND45 [R] 00000000 00000000		INTPND35 [R] 00000000 00000000		
$00C5A8_H$	INTPND65 [R] 00000000 00000000		INTPND55 [R] 00000000 00000000		
$00C5AC_H$	INTPND85 [R] 00000000 00000000		INTPND75 [R] 00000000 00000000		
$00C5B0_H$	MSGVAL25 [R] 00000000 00000000		MSGVAL15 [R] 00000000 00000000		
$00C5B4_H$	MSGVAL45 [R] 00000000 00000000		MSGVAL35 [R] 00000000 00000000		
$00C5B8_H$	MSGVAL65 [R] 00000000 00000000		MSGVAL55 [R] 00000000 00000000		
$00C5BC_H$	MSGVAL85 [R] 00000000 00000000		MSGVAL75 [R] 00000000 00000000		
$00C5C0_H$ to $00EFFC_H$	Reserved				

Address	Register				Block
	+0	+1	+2	+3	
$00F000_H$	BCTRL [R/W] -------- -------- 11111100 00000000				EDSU / MPU
$00F004_H$	BSTAT [R/W] -------- -----000 00000000 10--0000				
$00F008_H$	BIAC [R] 00000000 00000000 00000000 00000000				
$00F00C_H$	BOAC [R] 00000000 00000000 00000000 00000000				
$00F010_H$	BIRQ [R/W] 00000000 00000000 00000000 00000000				
$00F014_H$ to $00F01C_H$	Reserved				
$00F020_H$	BCR0 [R/W] -------- 00000000 00000000 00000000				
$00F024_H$	BCR1 [R/W] -------- 00000000 00000000 00000000				
$00F028_H$	BCR2 [R/W] -------- 00000000 00000000 00000000				
$00F02C_H$	BCR3 [R/W] -------- 00000000 00000000 00000000				
$00F030_H$ to $00F03C_H$	Reserved				
$00F040_H$ to $00F07C_H$	Reserved				Reserved
$00F080_H$	BAD0 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				EDSU / MPU
$00F084_H$	BAD1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F088_H$	BAD2 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F08C_H$	BAD3 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F090_H$	BAD4 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F094_H$	BAD5 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F098_H$	BAD6 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F09C_H$	BAD7 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0A0_H$	BAD8 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

Address	Register				Block
	+0	+1	+2	+3	
$00F0A4_H$	BAD9 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				EDSU / MPU
$00F0A8_H$	BAD10 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0AC_H$	BAD11 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0B0_H$	BAD12 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0B4_H$	BAD13 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0B8_H$	BAD14 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0BC_H$	BAD15 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00F0C0_H$ to $00F0FC_H$	Reserved				
$00F100_H$ to $02DFFC_H$	Reserved				Reserved
$02E000_H$ to $02FFFC_H$	CY91F463NA/F463NC Data RAM size is 8 Kbytes: $02E000_H$ to $02FFFF_H$ (data access is 0 wait cycle)				D-RAM 8 Kbytes
030000_H to $0307FC_H$	CY91F463NA/F463NC Instruction/data RAM size is 2 Kbytes: 030000_H to $0307FF_H$ (instruction access is 0 wait cycle, data access is 1 wait cycle)				I/D-RAM 2 Kbytes
030800_H to $0BFFFC_H$	Reserved				Reserved
$0C0000_H$ to $0DFFFC_H$	ROMS04 area (128 Kbytes)				Flash memory 256 Kbytes
$0E0000_H$ to $0FFFF4_H$	ROMS05 area (128 Kbytes)				
$0FFFF8_H$	FMV [R] $XXXXXXXX_H$				Reset/Mode Vector
$0FFFFC_H$	FRV [R] $XXXXXXXX_H$				
100000_H to $147FFC_H$	Reserved				Reserved
148000_H to $14FFFC_H$	ROMS07 area (32 Kbytes)				Flash memory 32 Kbytes
148000_H to $4FFFFC_H$	Reserved				Reserved

1. The lower 16 bits (DTC15 to DTC0) of DMACA0 to DMACA4 cannot be accessed in bytes.

14. Interrupt Source Table

Interrupt source	Interrupt number		Interrupt level		Interrupt vector		Resource number[1]
	Decimal	Hexa-decimal	Setting register	Register address	Offset	Default vector address	
Reset	0	00	-	-	$3FC_H$	$000FFFFC_H$	-
Mode vector	1	01	-	-	$3F8_H$	$000FFFF8_H$	-
System reserved	2	02	-	-	$3F4_H$	$000FFFF4_H$	-
System reserved	3	03	-	-	$3F0_H$	$000FFFF0_H$	-
System reserved	4	04	-	-	$3EC_H$	$000FFFEC_H$	-
CPU supervisor mode (INT #5 instruction) [2]	5	05	-	-	$3E8_H$	$000FFFE8_H$	-
Memory protection exception [2]	6	06	-	-	$3E4_H$	$000FFFE4_H$	-
System reserved	7	07	-	-	$3E0_H$	$000FFFE0_H$	-
System reserved	8	08	-	-	$3DC_H$	$000FFFDC_H$	-
System reserved	9	09	-	-	$3D8_H$	$000FFFD8_H$	-
System reserved	10	0A	-	-	$3D4_H$	$000FFFD4_H$	-
System reserved	11	0B	-	-	$3D0_H$	$000FFFD0_H$	-
System reserved	12	0C	-	-	$3CC_H$	$000FFFCC_H$	-
System reserved	13	0D	-	-	$3C8_H$	$000FFFC8_H$	-
Undefined instruction exception	14	0E	-	-	$3C4_H$	$000FFFC4_H$	-
NMI request	15	0F	F_H fixed		$3C0_H$	$000FFFC0_H$	-
External interrupt 0	16	10	ICR00	440_H	$3BC_H$	$000FFFBC_H$	0, 16
External interrupt 1	17	11			$3B8_H$	$000FFFB8_H$	1, 17
External interrupt 2	18	12	ICR01	441_H	$3B4_H$	$000FFFB4_H$	2, 18
External interrupt 3	19	13			$3B0_H$	$000FFFB0_H$	3, 19
External interrupt 4	20	14	ICR02	442_H	$3AC_H$	$000FFFAC_H$	20
External interrupt 5	21	15			$3A8_H$	$000FFFA8_H$	21
External interrupt 6	22	16	ICR03	443_H	$3A4_H$	$000FFFA4_H$	22
External interrupt 7	23	17			$3A0_H$	$000FFFA0_H$	23
System reserved	24	18	ICR04	444_H	$39C_H$	$000FFF9C_H$	-
System reserved	25	19			398_H	$000FFF98_H$	-
System reserved	26	1A	ICR05	445_H	394_H	$000FFF94_H$	-
System reserved	27	1B			390_H	$000FFF90_H$	-
External interrupt 12	28	1C	ICR06	446_H	$38C_H$	$000FFF8C_H$	-
External interrupt 13	29	1D			388_H	$000FFF88_H$	-
System reserved	30	1E	ICR07	447_H	384_H	$000FFF84_H$	-
System reserved	31	1F			380_H	$000FFF80_H$	-
Reload timer 0	32	20	ICR08	448_H	$37C_H$	$000FFF7C_H$	4, 32
Reload timer 1	33	21			378_H	$000FFF78_H$	5, 33
Reload timer 2	34	22	ICR09	449_H	374_H	$000FFF74_H$	34
Reload timer 3	35	23			370_H	$000FFF70_H$	35
System reserved	36	24	ICR10	$44A_H$	$36C_H$	$000FFF6C_H$	36
System reserved	37	25			368_H	$000FFF68_H$	37

Interrupt source	Interrupt number		Interrupt level		Interrupt vector		Resource number[1]
	Decimal	Hexa-decimal	Setting register	Register address	Offset	Default vector address	
System reserved	38	26	ICR11	$44B_H$	364_H	$000FFF64_H$	38
Reload timer 7	39	27			360_H	$000FFF60_H$	39
Free-run timer 0	40	28	ICR12	$44C_H$	$35C_H$	$000FFF5C_H$	40
Free-run timer 1	41	29			358_H	$000FFF58_H$	41
Free-run timer 2	42	2A	ICR13	$44D_H$	354_H	$000FFF54_H$	42
Free-run timer 3	43	2B			350_H	$000FFF50_H$	43
System reserved	44	2C	ICR14	$44E_H$	$34C_H$	$000FFF4C_H$	44
System reserved	45	2D			348_H	$000FFF48_H$	45
System reserved	46	2E	ICR15	$44F_H$	344_H	$000FFF44_H$	46
System reserved	47	2F			340_H	$000FFF40_H$	47
System reserved	48	30	ICR16	450_H	$33C_H$	$000FFF3C_H$	-
System reserved	49	31			338_H	$000FFF38_H$	-
System reserved	50	32	ICR17	451_H	334_H	$000FFF34_H$	-
System reserved	51	33			330_H	$000FFF30_H$	-
CAN 4	52	34	ICR18	452_H	$32C_H$	$000FFF2C_H$	-
CAN 5	53	35			328_H	$000FFF28_H$	-
LIN-USART0 RX	54	36	ICR19	453_H	324_H	$000FFF24_H$	6, 48
LIN-USART0 TX	55	37			320_H	$000FFF20_H$	7, 49
LIN-USART1 RX	56	38	ICR20	454_H	$31C_H$	$000FFF1C_H$	8, 50
LIN-USART1 TX	57	39			318_H	$000FFF18_H$	9, 51
LIN-USART2 RX	58	3A	ICR21	455_H	314_H	$000FFF14_H$	52
LIN-USART2 TX	59	3B			310_H	$000FFF10_H$	53
LIN-USART3 RX	60	3C	ICR22	456_H	$30C_H$	$000FFF0C_H$	54
LIN-USART3 TX	61	3D			308_H	$000FFF08_H$	55
System reserved	62	3E	ICR23 [3]	457_H	304_H	$000FFF04_H$	-
Delayed interrupt	63	3F			300_H	$000FFF00_H$	-
System reserved [4]	64	40	(ICR24)	(458_H)	$2FC_H$	$000FFEFC_H$	-
System reserved [4]	65	41			$2F8_H$	$000FFEF8_H$	-
System reserved	66	42	ICR25	459_H	$2F4_H$	$000FFEF4_H$	10, 56
System reserved	67	43			$2F0_H$	$000FFEF0_H$	11, 57
System reserved	68	44	ICR26	$45A_H$	$2EC_H$	$000FFEEC_H$	12, 58
System reserved	69	45			$2E8_H$	$000FFEE8_H$	13, 59
System reserved	70	46	ICR27	$45B_H$	$2E4_H$	$000FFEE4_H$	60
System reserved	71	47			$2E0_H$	$000FFEE0_H$	61
System reserved	72	48	ICR28	$45C_H$	$2DC_H$	$000FFEDC_H$	62
System reserved	73	49			$2D8_H$	$000FFED8_H$	63
I^2C 2	74	4A	ICR29	$45D_H$	$2D4_H$	$000FFED4_H$	-
I^2C 3	75	4B			$2D0_H$	$000FFED0_H$	-

Interrupt source	Interrupt number		Interrupt level		Interrupt vector		Resource number[1]
	Decimal	Hexa-decimal	Setting register	Register address	Offset	Default vector address	
System reserved	76	4C	ICR30	$45E_H$	$2CC_H$	$000FFECC_H$	64
System reserved	77	4D			$2C8_H$	$000FFEC8_H$	65
System reserved	78	4E	ICR31	$45F_H$	$2C4_H$	$000FFEC4_H$	66
System reserved	79	4F			$2C0_H$	$000FFEC0_H$	67
System reserved	80	50	ICR32	460_H	$2BC_H$	$000FFEBC_H$	68
System reserved	81	51			$2B8_H$	$000FFEB8_H$	69
System reserved	82	52	ICR33	461_H	$2B4_H$	$000FFEB4_H$	70
System reserved	83	53			$2B0_H$	$000FFEB0_H$	71
System reserved	84	54	ICR34	462_H	$2AC_H$	$000FFEAC_H$	72
System reserved	85	55			$2A8_H$	$000FFEA8_H$	73
System reserved	86	56	ICR35	463_H	$2A4_H$	$000FFEA4_H$	74
System reserved	87	57			$2A0_H$	$000FFEA0_H$	75
System reserved	88	58	ICR36	464_H	$29C_H$	$000FFE9C_H$	76
System reserved	89	59			298_H	$000FFE98_H$	77
System reserved	90	5A	ICR37	465_H	294_H	$000FFE94_H$	78
System reserved	91	5B			290_H	$000FFE90_H$	79
Input capture 0	92	5C	ICR38	466_H	$28C_H$	$000FFE8C_H$	80
Input capture 1	93	5D			288_H	$000FFE88_H$	81
Input capture 2	94	5E	ICR39	467_H	284_H	$000FFE84_H$	82
Input capture 3	95	5F			280_H	$000FFE80_H$	83
System reserved	96	60	ICR40	468_H	$27C_H$	$000FFE7C_H$	84
System reserved	97	61			278_H	$000FFE78_H$	85
System reserved	98	62	ICR41	469_H	274_H	$000FFE74_H$	86
System reserved	99	63			270_H	$000FFE70_H$	87
Output compare 0	100	64	ICR42	$46A_H$	$26C_H$	$000FFE6C_H$	88
Output compare 1	101	65			268_H	$000FFE68_H$	89
Output compare 2	102	66	ICR43	$46B_H$	264_H	$000FFE64_H$	90
Output compare 3	103	67			260_H	$000FFE60_H$	91
System reserved	104	68	ICR44	$46C_H$	$25C_H$	$000FFE5C_H$	92
System reserved	105	69			258_H	$000FFE58_H$	93
System reserved	106	6A	ICR45	$46D_H$	254_H	$000FFE54_H$	94
System reserved	107	6B			250_H	$000FFE50_H$	95
System reserved	108	6C	ICR46	$46E_H$	$24C_H$	$000FFE4C_H$	-
Phase Frequency modulator	109	6D			248_H	$000FFE48_H$	-
System reserved	110	6E	ICR47 [4]	$46F_H$	244_H	$000FFE44_H$	-
System reserved	111	6F			240_H	$000FFE40_H$	-
PPG0	112	70	ICR48	470_H	$23C_H$	$000FFE3C_H$	15, 96
PPG1	113	71			238_H	$000FFE38_H$	97

Interrupt source	Interrupt number		Interrupt level		Interrupt vector		Resource number[1]
	Decimal	Hexa-decimal	Setting register	Register address	Offset	Default vector address	
PPG2	114	72	ICR49	471_H	234_H	$000FFE34_H$	98
PPG3	115	73			230_H	$000FFE30_H$	99
PPG4	116	74	ICR50	472_H	$22C_H$	$000FFE2C_H$	100
PPG5	117	75			228_H	$000FFE28_H$	101
PPG6	118	76	ICR51	473_H	224_H	$000FFE24_H$	102
PPG7	119	77			220_H	$000FFE20_H$	103
System reserved	120	78	ICR52	474_H	$21C_H$	$000FFE1C_H$	104
System reserved	121	79			218_H	$000FFE18_H$	105
System reserved	122	7A	ICR53	475_H	214_H	$000FFE14_H$	106
System reserved	123	7B			210_H	$000FFE10_H$	107
System reserved	124	7C	ICR54	476_H	$20C_H$	$000FFE0C_H$	108
System reserved	125	7D			208_H	$000FFE08_H$	109
System reserved	126	7E	ICR55	477_H	204_H	$000FFE04_H$	110
System reserved	127	7F			200_H	$000FFE00_H$	111
Up/down counter 0	128	80	ICR56	478_H	$1FC_H$	$000FFDFC_H$	-
Up/down counter 1	129	81			$1F8_H$	$000FFDF8_H$	-
System reserved	130	82	ICR57	479_H	$1F4_H$	$000FFDF4_H$	-
System reserved	131	83			$1F0_H$	$000FFDF0_H$	-
Real time clock	132	84	ICR58	$47A_H$	$1EC_H$	$000FFDEC_H$	-
Calibration unit	133	85			$1E8_H$	$000FFDE8_H$	-
A/D converter 0	134	86	ICR59	$47B_H$	$1E4_H$	$000FFDE4_H$	14, 112
System reserved	135	87			$1E0_H$	$000FFDE0_H$	-
System reserved	136	88	ICR60	$47C_H$	$1DC_H$	$000FFDDC_H$	-
System reserved	137	89			$1D8_H$	$000FFDD8_H$	-
Low voltage detection	138	8A	ICR61	$47D_H$	$1D4_H$	$000FFDD4_H$	-
System reserved	139	8B			$1D0_H$	$000FFDD0_H$	-
Time-base overflow	140	8C	ICR62	$47E_H$	$1CC_H$	$000FFDCC_H$	-
PLL clock gear	141	8D			$1C8_H$	$000FFDC8_H$	-
DMA controller	142	8E	ICR63	$47F_H$	$1C4_H$	$000FFDC4_H$	-
Main OSC stability wait	143	8F			$1C0_H$	$000FFDC0_H$	-
System reserved	144	90	-	-	$1BC_H$	$000FFDBC_H$	-
Used by the INT instruction	145 to 255	91 to FF	-	-	$1B8_H$ to 000_H	$000FFDB8_H$ to $000FFC00_H$	-

1.The peripheral resources to which RN (Resource Number) is assigned are capable of being DMA transfer activation sources. In addition, RN respectively corresponds to an IS (Input Source)of the DMAC channel control register A(DMACA0 to DMACA4), and the IS (Input Source) can be obtained by representing RN in a binary number and adding “1” to the head of it.
2.Memory Protection Unit (MPU) support
3.ICR23 can be switched to ICR47 by setting REALOS compatibility bit (address $0C03_H$ ISO[0]).
4.Used by REALOS

15. Electrical Characteristics

15.1 Absolute Maximum Rating

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage[1]	V_{CC}	V_{SS} − 0.5	V_{SS} + 6.0	V	
Analog power supply voltage[1]	AV_{CC}	V_{SS} − 0.5	V_{SS} + 6.0	V	[2]
Analog power supply voltage[1]	AVRH	V_{SS} − 0.5	V_{SS} + 6.0	V	[2]
Input voltage[1]	V_I	V_{SS} − 0.3	V_{CC} + 0.3	V	[3]
Analog pin input voltage[1]	V_{IA}	V_{SS} − 0.3	AV_{CC} + 0.3	V	
Output voltage[1]	V_O	V_{SS} − 0.3	V_{CC} + 0.3	V	[3]
Maximum clamp current	I_{CLAMP}	− 2.0	+2.0	mA	[4]
Total maximum clamp current	$\Sigma\|I_{CLAMP}\|$	-	20	mA	[4]
“L” level maximum output current	I_{OL}	-	10	mA	[5]
“L” level average output current	I_{OLAV}	-	4	mA	[6]
“L” level total maximum output current	ΣI_{OL}	-	100	mA	
“L” level total average output current	ΣI_{OLAV}	-	50	mA	[7]
“H” level maximum output current	I_{OH}	-	− 10	mA	[5]
“H” level average output current	I_{OHAV}	-	− 4	mA	[6]
“H” level total maximum output current	ΣI_{OH}	-	− 100	mA	
“H” level total average output current	ΣI_{OHAV}	-	− 20	mA	[7]
Power consumption	P_D	-	700	mW	
Operation temperature	T_A	−40	+105	°C	When using V_{CC} = 3.3 V
		−40	+85	°C	When using V_{CC} = 5.0 V
Storage temperature	Tstg	− 55	+ 125	°C	

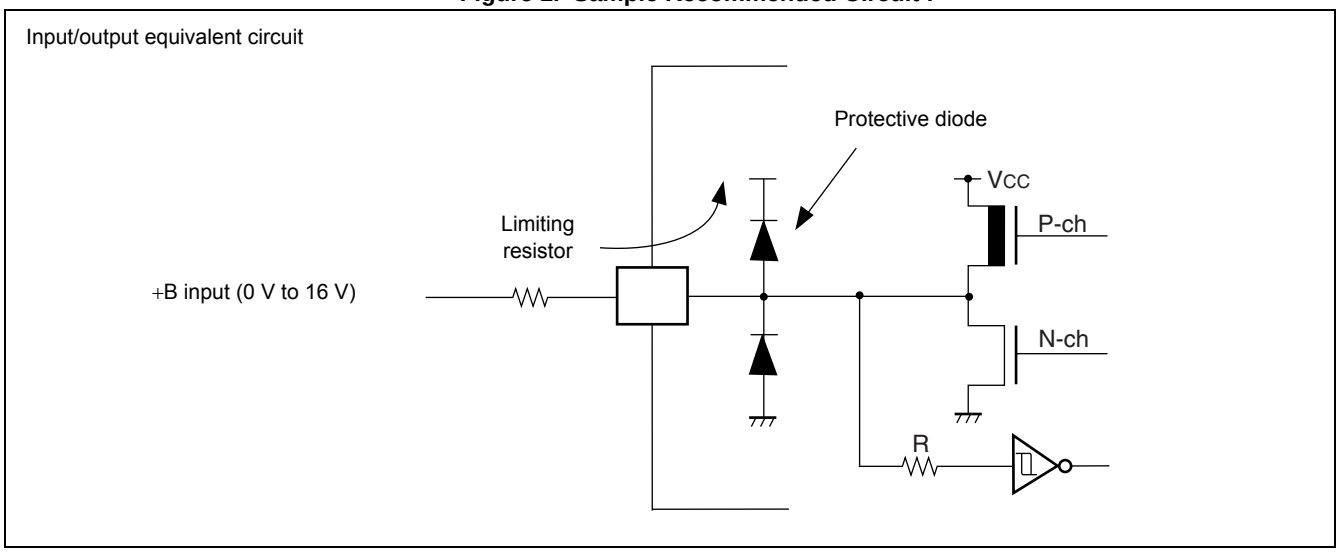
1. The parameter is based on $V_{SS} = AV_{SS} = 0.0$ V.
2. AV_{CC} and AVRH must not exceed V_{CC} + 0.3 V, for example, at power on. AV_{CC} must not exceed V_{CC}.
3. V_I and V_O must not exceed V_{CC} + 0.3V. However, when the maximum value of the current to the input or the current from the input is limited by using outside parts, I_{CLAMP} ratings are applied in place of V_I ratings.

4.

- Corresponding pins: Pin name P29_0 to P29_7, P24_0 to P24_7, P22_0 to P22_3, P20_0 to P20_2, P20_4 to P20_6, P15_0 to P15_3, P17_0 to P17_7, P21_0 to P21_2, P21_4 to P21_6, P14_0 to P14_3
- Use within recommended operating conditions.
- Use at DC voltage (current).
- The + B signal is an input signal exceeding V_{CC} voltage. The + B signal should always be applied by connecting a limiting resistor between the + B signal and the microcontroller.
- The value of the limiting resistor should be set so that the current input to the microcontroller pin does not exceed rated values at any time regardless of instantaneously or constantly when the + B signal is input.
- Note that when the microcontroller drive current is low, such as in the low power consumption modes, the + B input potential can increase the potential at the VCC pin via a protective diode, possibly affecting other devices.
- Note that if the + B signal is input when the microcontroller is off (not fixed at 0 V), since the power is supplied through the pin, the microcontroller may operate incompletely.
- Note that if the + B signal is input at power-on, since the power is supplied through the pin, the power supply voltage may become the voltage at which a power-on reset does not work.
- Do not leave + B input pins open.
  ″Note that analog input/output pins can input the + B signal only at using as a port.

5. Maximum output current is defined as the value of the peak current flowing through any one of the corresponding pins.
6. Average output current is defined as the value of the average current flowing through any one of the corresponding pins for a 100 ms period.
7. Total average output current is defined as the value of the average current flowing through all of the corresponding pins for a 100 ms period.

Figure 1. Sample Recommended Circuit :



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

15.2 Recommended Operating Conditions

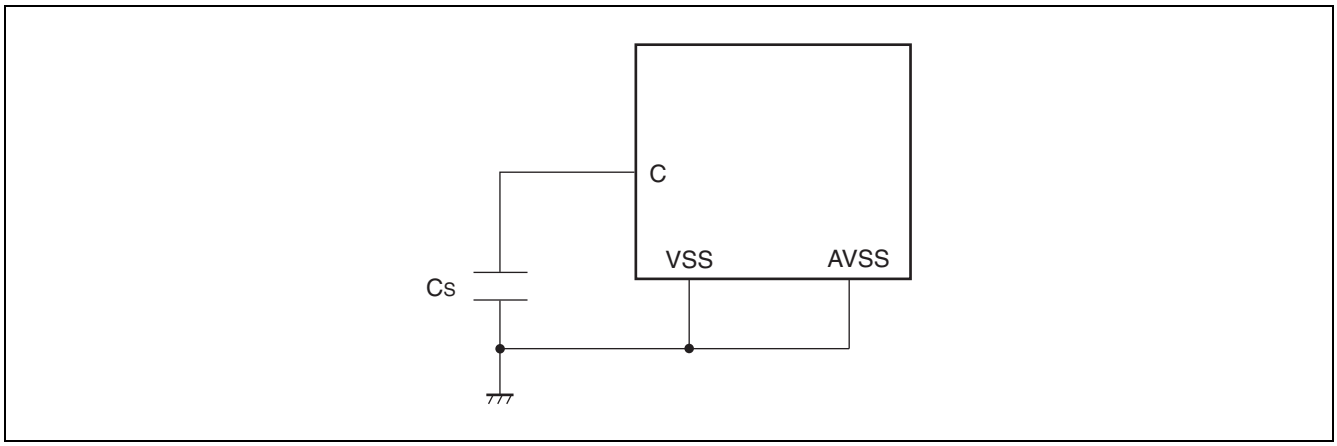
(V_{SS} = AV_{SS} = 0.0 V)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC}	3.0	3.6	V	When using V_{CC} = 3.3 V
		4.5	5.5	V	When using V_{CC} = 5.0 V
	AV_{CC}	3.0	3.6	V	When using V_{CC} = 3.3 V
		4.5	5.5	V	When using V_{CC} = 5.0 V
Smoothing capacitor	C_S	4.7 (accuracy within ± 50%)		µF	Use a ceramic capacitor or a capacitor that has the similar frequency characteristics. Use a capacitor with a capacitance greater than C_S as the smoothing capacitor on the VCC pin.
Operating temperature	T_A	−40	+105	°C	When using V_{CC} = 3.3 V
		−40	+85	°C	When using V_{CC} = 5.0 V

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.



15.3 DC Characteristics

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IHS}	Port pin	When CMOS hysteresis input type1 are selected	0.7 × V_{CC}	-	V_{CC} + 0.3	V	
	V_{IHC}	Port pin	When CMOS hysteresis input type2 are selected	0.8 × V_{CC}	-	V_{CC} + 0.3	V	
	V_{IHA}	Port pin	When Automotive inputs are selected	0.8 × V_{CC}	-	V_{CC} + 0.3	V	
	V_{IHT}	Port pin	When TTL input levels are selected	2.0	-	V_{CC} + 0.3	V	
	V_{IH1}	MD2 to MD0	CMOS level input	0.7 × V_{CC}	-	V_{CC} + 0.3	V	
	V_{IH2}	MD3, INITX	CMOS hysteresis input	0.7 × V_{CC}	-	V_{CC} + 0.3	V	
"L" level input voltage	V_{ILS}	Port pin	When CMOS hysteresis input type1 are selected	V_{SS} – 0.3	-	0.3 × V_{CC}	V	
	V_{ILC}	Port pin	When CMOS hysteresis input type2 are selected	V_{SS} – 0.3	-	0.2 × V_{CC}	V	
	V_{ILA}	Port pin	When Automotive inputs are selected	V_{SS} – 0.3	-	0.5 × V_{CC}	V	
	V_{ILT}	Port pin	When TTL input levels are selected	V_{SS} – 0.3	-	0.8	V	
	V_{IL1}	MD2 to MD0	CMOS level input	V_{SS} – 0.3	-	0.3 × V_{CC}	V	
	V_{IL2}	MD3, INITX	CMOS hysteresis input	V_{SS} – 0.3	-	0.3 × V_{CC}	V	
"H" level output voltage	V_{OH1}	Port pin	V_{CC} = 5.0 V, I_{OH} = –2.0 mA/ V_{CC} = 3.3 V, I_{OH} = –1.0 mA	V_{CC} – 0.5	-	-	V	[1]
	V_{OH2}	I^2C common port pin	V_{CC} = 5.0 V, I_{OH} = –3.0 mA/ V_{CC} = 3.3 V, I_{OH} = –3.0 mA	V_{CC} – 0.5	-	-	V	
	V_{OH3}	Port pin	V_{CC} = 5.0 V, I_{OH} = –5.0 mA/ V_{CC} = 3.3 V, I_{OH} = –3.0 mA	V_{CC} – 0.5	-	-	V	[1]

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"L" level output voltage	V_{OL1}	Port pin	V_{CC} = 5.0 V, I_{OH} = –2.0 mA/ V_{CC} = 3.3 V, I_{OH} = –1.0 mA	-	-	0.4	V	[1]
	V_{OL2}	I^2C common port pin	V_{CC} = 5.0 V, I_{OH} = –3.0 mA/ V_{CC} = 3.3 V, I_{OH} = –3.0 mA	-	-	0.4	V	
	V_{OL3}	Port pin	V_{CC} = 5.0 V, I_{OH} = –5.0 mA/ V_{CC} = 3.3 V, I_{OH} = –3.0 mA	-	-	0.4	V	[1]
Input leak current	I_{IL}	-	V_{CC} = AV_{CC} = 5.0 V, V_{SS} < V_I < V_{CC}	–5	-	+ 5	µA	
Pull-up resistance value	R_{UP}	Port pin	-	25	50	100	kΩ	
Pull-down resistance value	R_{DOWN}	Port pin	-	25	50	100	kΩ	

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current	I_{CC3}	VCC	V_{CC} = 3.3 V CPU core: 80 MHz,	-	75	102	mA	T_A = –40°C to +105°C
	I_{CC5}	VCC	V_{CC} = 5.0 V CPU core: 80 MHz,	-	75	102	mA	T_A = –40°C to +85°C
	I_{CCS3}	VCC	V_{CC} = 3.3 V sleep mode	-	15	45	mA	
	I_{CCS5}	VCC	V_{CC} = 5.0 V sleep mode	-	15	45	mA	
	I_{CTS3}	VCC	V_{CC} = 3.3 V stop mode at using RTC) [3]	-	100	550	µA	T_A = + 25°C When the CR oscillator is operating and low voltage detection is enabled.
	I_{CTS5}	VCC	V_{CC} = 5.0 V stop mode at using RTC) [3]	-	200	650	µA	T_A = + 25°C When the CR oscillator is operating and low voltage detection is enabled.
	I_{CCH3}	VCC	V_{CC} = 3.3 V stop modeoscillation stop) [4]	-	100	500	µA	T_A = + 25°C When the CR oscillator is stopping and low voltage detection is enabled.
	I_{CCH5}	VCC	V_{CC} = 5.0 V stop modeoscillation stop) [4]	-	150	600	µA	T_A = + 25°C When the CR oscillator is stopping and low voltage detection is enabled.
	I_{CCF}	VCC	Flash programming (Write/Erase)	-	25	50	mA	[2]
Input capacitance	C_{IN}	Except VCC, AVCC, VSS, AVSS	-	-	5	15	pF	

1. The drive power varies depending on the power supply voltage (3.3 V, 5.0 V).
2. The power supply current when writing or erasing by executing the automatic algorithm.
3. When the main clock oscillator is stopped and CR oscillator is operating (using the CR oscillator clock in the RTC) and the low voltage detection is enabled.
4. When the main clock oscillator is stopped, the CR oscillator is stopped and the low voltage detection is enabled.

15.4 AC Characteristics

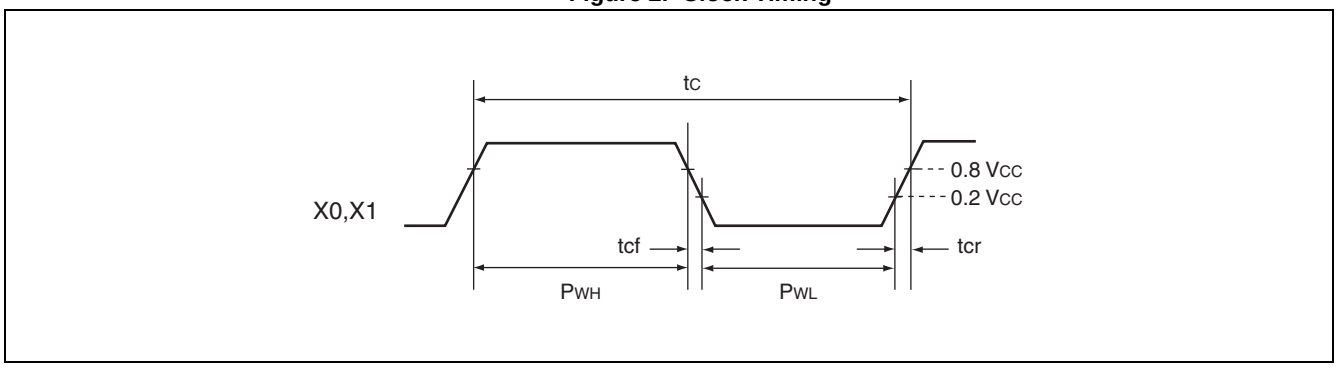
15.4.1 Clock Timing

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 125°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F_C	X0, X1	-	3.5	4	16	MHz	When using the oscillator circuit
				3.5	-	32	MHz	When using an external clock
Clock cycle time	t_C	X0, X1		62.5	-	285.7	ns	When using the oscillator circuit
				31.25	-	285.7	ns	When using an external clock
Internal operation clock frequency	F_{CP}	-		-	-	80	MHz	CPU clock, when using PLL[1]
	F_{CPP}	-		-	-	40	MHz	Peripheral clock
Internal operation clock cycle time	t_{CP}	-		12.5	-	-	ns	CPU clock, when using PLL
	t_{CPP}	-		25	-	-	ns	Peripheral clock
Input clock pulse width	P_{WH}, P_{WL}	X0		30	-	-	ns	
Input clock rise/fall time	tcf, tcr	X0		-	-	5	ns	

1. When using the clock modulator, set such that the maximum value of the modulated frequency is 96 MHz or less.

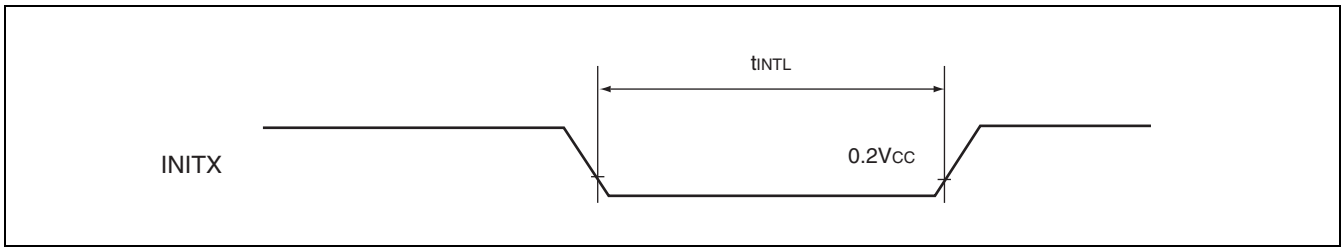
Figure 2. Clock Timing



15.4.2 Reset Input

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

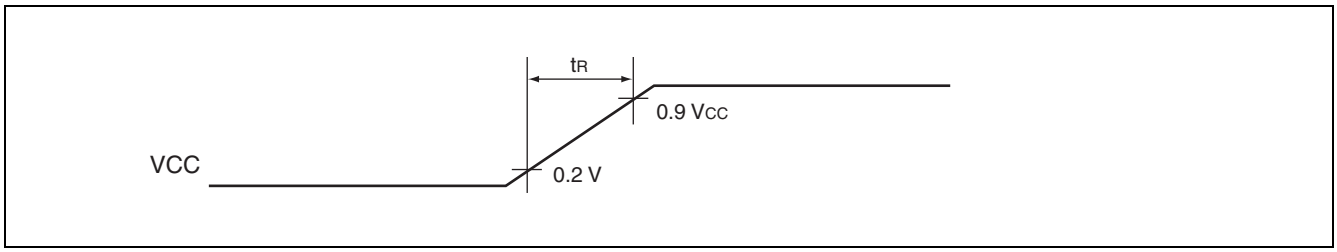
Parameter	Symbol	Pin Name	Condition	Value		Unit
				Min	Max	
INITX input time (at power-on or stop mode)	t_{INTL}	INITX	-	Oscillation stabilization time of oscillator + 2.6	-	ms
INITX input time (other than the above)				20	-	µs



15.4.3 Specification for Power-on

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Condition	Value		Unit
				Min	Max	
Power supply rising time	t_R	VCC	-	0.1	100	ms
Power supply start time	-	-	-	0.2	-	V
Power supply end time	-	-	-	-	0.9 × V_{CC}	V



15.4.4 LIN-USART Timing

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode	8 × t_{CLKP}	-	ns
SCK ↓→ SOT delay time	t_{SLOV}	SCK0 to SCK3, SOT0 to SOT3		– 80	+ 80	ns
Valid SIN → SCK ↑	t_{IVSH}	SCK0 to SCK3, SIN0 to SIN3		100	-	ns
SCK ↑→ valid SIN hold time	t_{SHIX}	SCK0 to SCK3, SIN0 to SIN3		60	-	ns
Serial clock “H” pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode	4 × t_{CLKP}	-	ns
Serial clock “L” pulse width	t_{SLSH}	SCK0 to SCK3		4 × t_{CLKP}	-	ns
SCK ↓→ SOT delay time	t_{SLOV}	SCK0 to SCK3, SOT0 to SOT3		-	150	ns
Valid SIN → SCK ↑	t_{IVSH}	SCK0 to SCK3, SIN0 to SIN3		60	-	ns
SCK ↑→ Valid SIN hold time	t_{SHIX}	SCK0 to SCK3, SIN0 to SIN3		60	-	ns

Notes:

- Above values are AC characteristics for CLK synchronous mode.
- t_{CLKP} is the cycle time of the peripheral clock.

Figure 3. Internal Shift Clock Mode

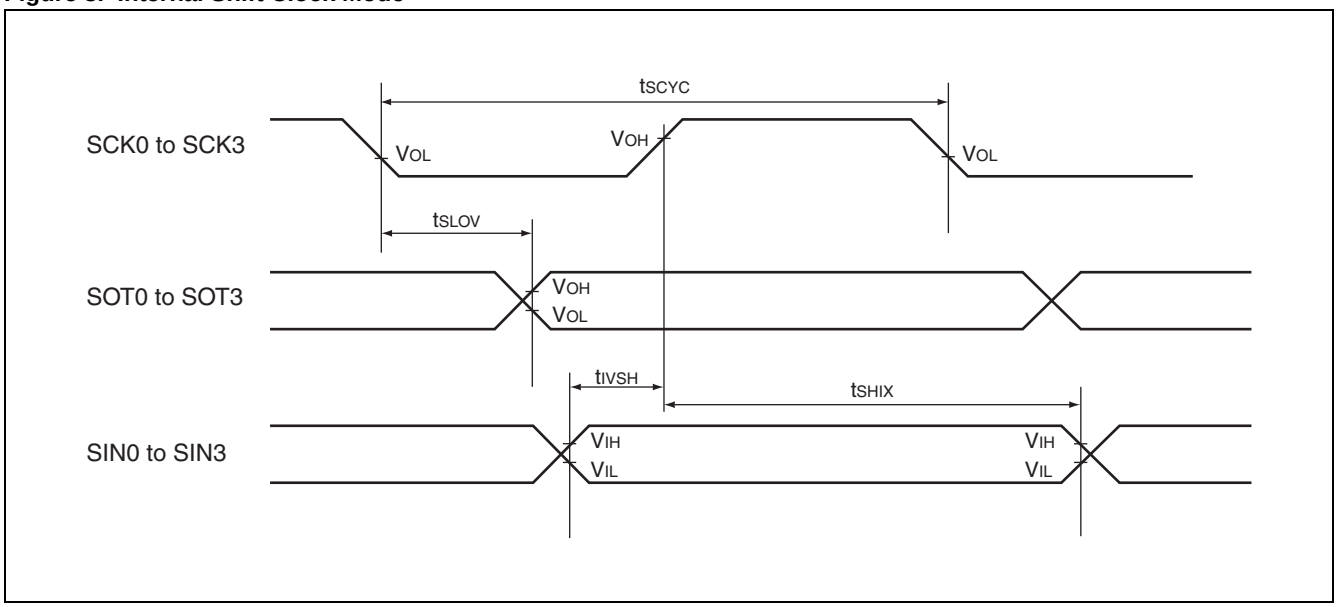
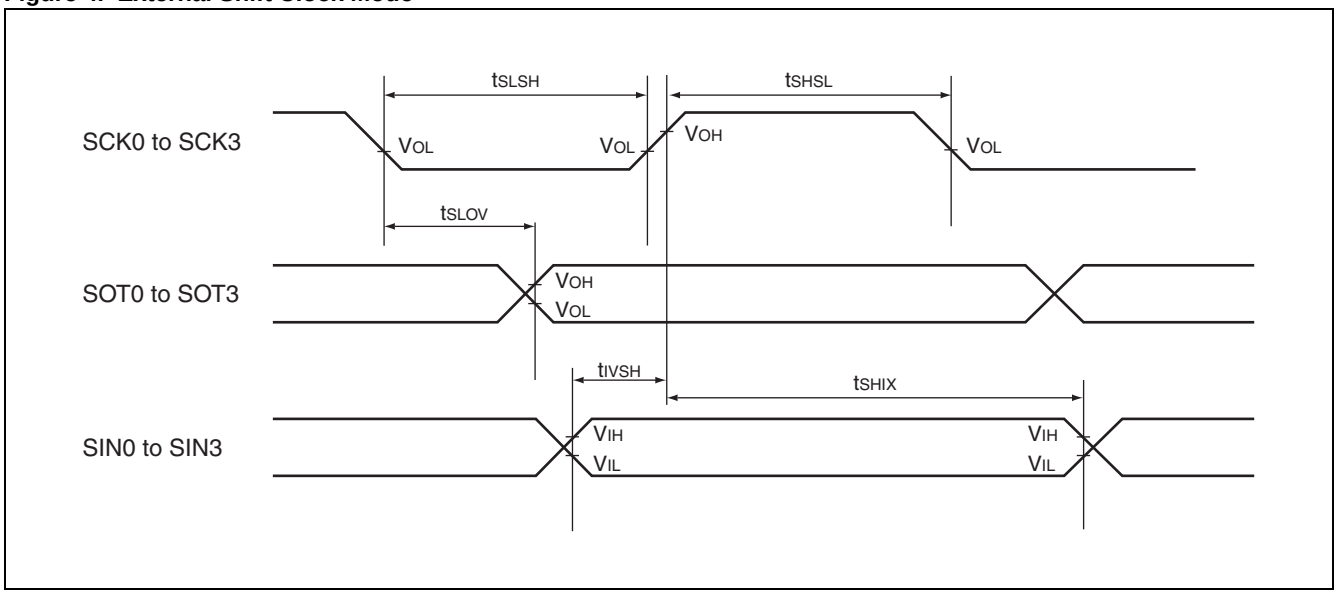


Figure 4. External Shift Clock Mode

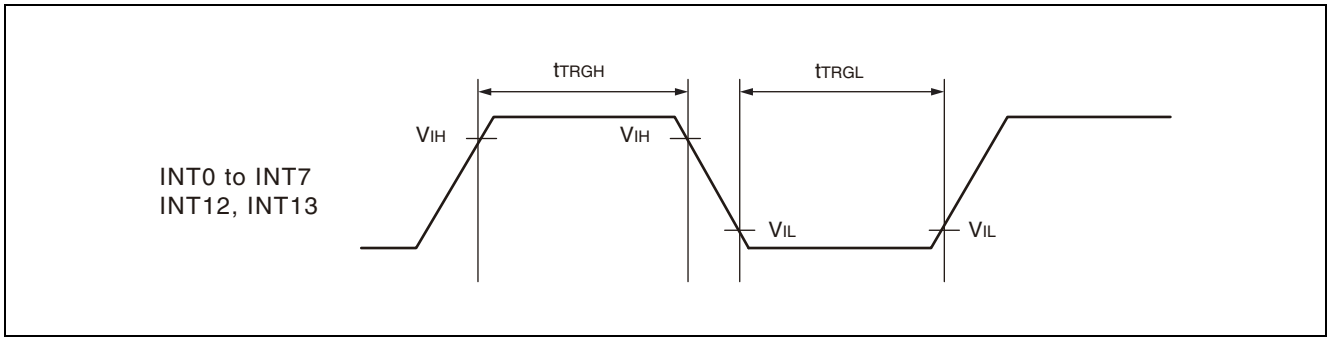


15.4.5 Trigger Input Timing

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Value		Unit
			Min	Max	
External interrupt input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT7 INT12, INT13	4 × t_{CLKP}	-	ns

Note: t_{CLKP} is the cycle time of the peripheral clock.

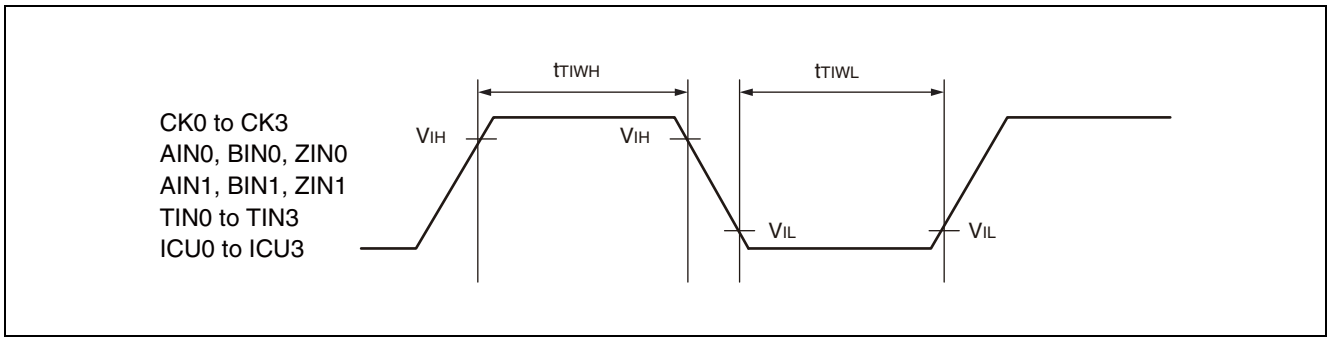


15.4.6 Timer Related Resource Input Timing

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40°C to + 105°C/–40°C to + 85°C)

Parameter	Symbol	Pin Name	Value		Unit
			Min	Max	
Free-run timer input clock pulse width	t_{TIWH} t_{TIWL}	CK0 to CK3	4 × t_{CLKP}	–	ns
Up/down counter input pulse width		AIN0, AIN1 BIN0, BIN1 ZIN0, ZIN1	4 × t_{CLKP}	–	ns
Reload timer input pulse width		TIN0 to TIN3	4 × t_{CLKP}	–	ns
Input capture input pulse width		ICU0 to ICU3	4 × t_{CLKP}	–	ns

Note: t_{CLKP} is the cycle time of the peripheral clock.



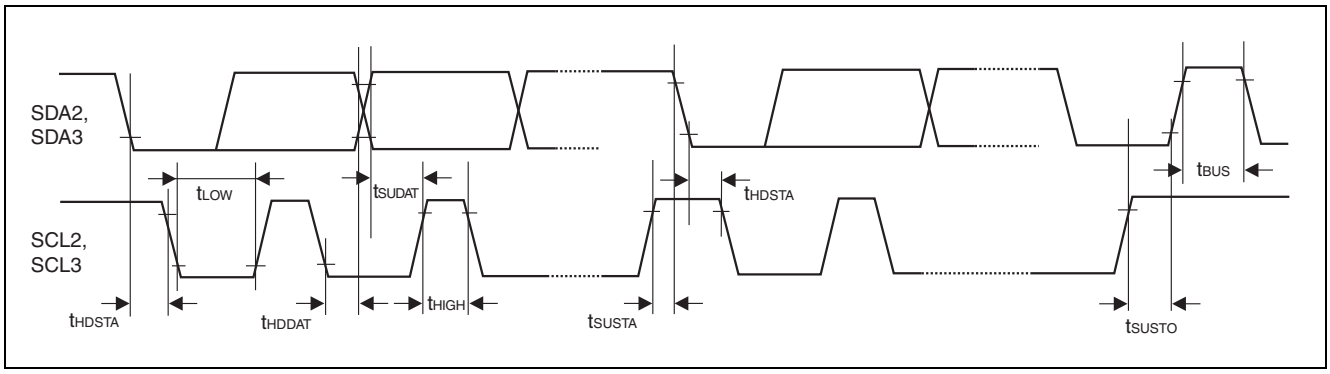
15.4.7 I²C Timing

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40 °C to + 105 °C/–40 °C to + 85 °C)

Parameter	Symbol	Pin Name	Condition	Standard Mode		Fast Mode [1]		Unit
				Min	Max	Min	Max	
SCL clock frequency	f_{SCL}	SDA2, SDA3, SCL2, SCL3	R = 1 kΩ, C = 50 pF[2]	0	100	0	400	kHz
"L" width of the SCL clock	t_{LOW}			4.7	–	1.3	–	µs
"H" width of the SCL clock	t_{HIGH}			4.0	–	0.6	–	µs
Bus free time between STOP and START conditions	t_{BUS}			4.7	–	1.3	–	µs
SCL ↑→ SDA output delay time	t_{DLDAT}			–	5 × t_{CLKP}	–	5 × t_{CLKP}	ns
Setup time for a repeated START condition SCL ↑→ SDA ↓	t_{SUSTA}			4.7	–	0.6	–	µs
Hold time for a repeated START condition SDA ↓→ SCL↓	t_{HDSTA}			4.0	–	0.6	–	µs
Setup time for STOP condition SCL ↑→ SDA ↑	t_{SUSTO}			4.0	–	0.6	–	µs
SDA data input hold time SCL ↓→ SDA ↓↑	t_{HDDAT}			2 × t_{CLKP}	–	2 × t_{CLKP}	–	µs
SDA data input setup time SDA ↓↑ → SCL ↑	t_{SUDAT}			250	–	100	–	ns

1. For use at over 100 kHz, set the peripheral clock to at least 6 MHz.
2. R and C are the pull-up resistance and load capacitance of the SCL and SDA lines.

Note: t_{CLKP} is the cycle time of the peripheral clock.



15.5 Electrical Characteristics for A/D Converter

(V_{CC} = 3.0 V to 3.6 V/ 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = –40 °C to + 105 °C/–40 °C to + 85 °C)

Parameter	Symbol	Pin Name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	–	–	–	–	10	bit	
Total error[1]	–	–	–	–	± 3	LSB	
Linearity error[1]	–	–	–	–	± 2.5	LSB	
Differential linearity error[1]	–	–	–	–	± 1.9	LSB	
Zero transition voltage[1]	V_{OT}	AN0 to AN7	AV_{SS}–1.5 LSB	AV_{SS}–0.5 LSB	AV_{SS}–2.5 LSB	V	
Full scale transition voltage[1]	V_{FST}	AN0 to AN7	AVRH–3.5 LSB	AVRH–1.5 LSB	AVRH–0.5 LSB	V	
Conversion time	–	–	1 [2]	–	–	µs	Using at 5 V
			3 [2]	–	–	µs	Using at 3.3 V
Analog port input current	I_{AIN}	AN0 to AN7	–	–	10	µA	
Analog input voltage	V_{AIN}	AN0 to AN7	AV_{SS}	–	AVRH	V	
Reference voltage	–	AVRH	AV_{SS}	–	AV_{CC}	V	
Analog power supply current (analog + digital)	I_A	AVCC	–	2.4	4.7	mA	Including reference supply
Reference voltage supply current	I_R	AVRH	–	0.65	1.0	mA	
Analog input equivalent capacitance	Cin	AN0 to AN7	–	–	8.5	pF	
Analog input equivalent resistance	Rin	AN0 to AN7	–	–	2.6	kΩ	AVcc ? 4.5 V
			–	–	12.1	kΩ	AVcc ? 3.0 V
Output impedance of analog signal source	Rext	–	–	–	4.2	kΩ	

1. Measured in the CPU sleep state
2. Set no shorter than this time period in the peripheral clock and conversion setting register

15.6 Notes on the A/D Converter

The diagram below shows the equivalent circuit of the sampling circuit in the A/D converter.

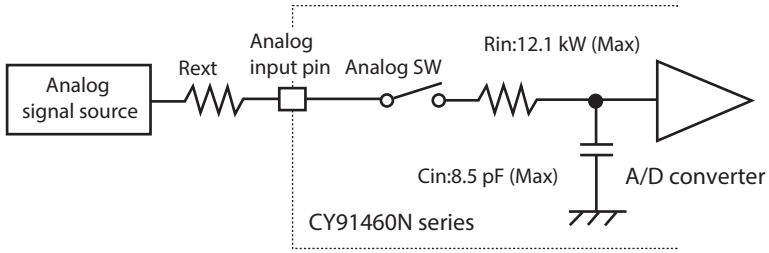
Apply the output impedance in the external circuit for the analog output under the following conditions.

- The recommended output impedance for the external circuit is 4.2 kΩ or less.
- If an external capacitor is used, remember to consider the capacitive voltage divider effect due to the external capacitor and the internal capacitor in the chip. Accordingly, an external capacitance several thousand times that of the internal capacitance is recommended.
- The analog voltage sampling period may be too short if the output impedance of the external circuit is high.In this case, select Rext and Tsamp to satisfy the following condition.

  Rext = Tsamp/ (7 Cin) – Rin

  Rext: Output impedance of the analog signal source
  Tsamp: Sampling time
  Cin: Equivalent capacitance of analog input
  Rin: Equivalent resistance of analog input

Input impedance



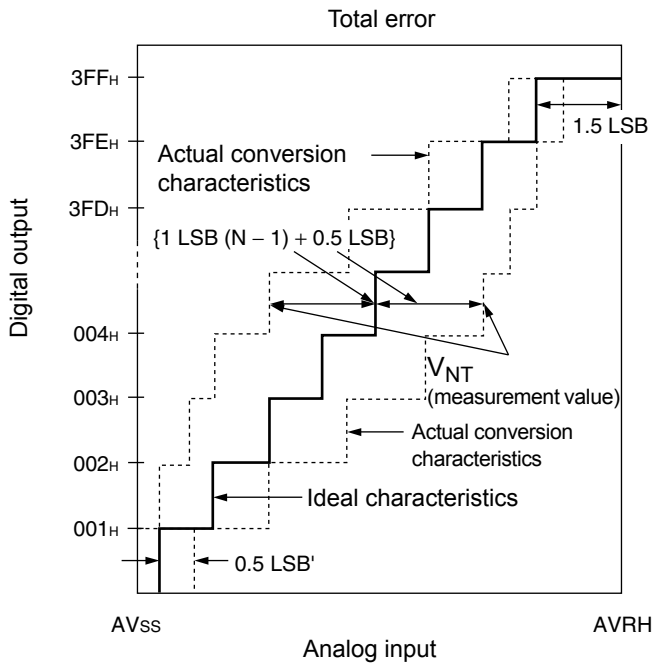
15.7 Definition of A/D Converter Terms

■ Resolution
Analog variation that is recognizable by an A/D converter.

■ Linearity error
Deviation between actual conversion characteristics and a straight line connecting zero transition point (00 0000 0000 ↔ 00 0000 0001) and full scale transition point (11 1111 1110 ↔ 11 1111 1111).

■ Differential linearity error
Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.

■ Total error
This error indicates the difference between actual and theoretical values, including the zero transition error/full scale transition error/linearity error.



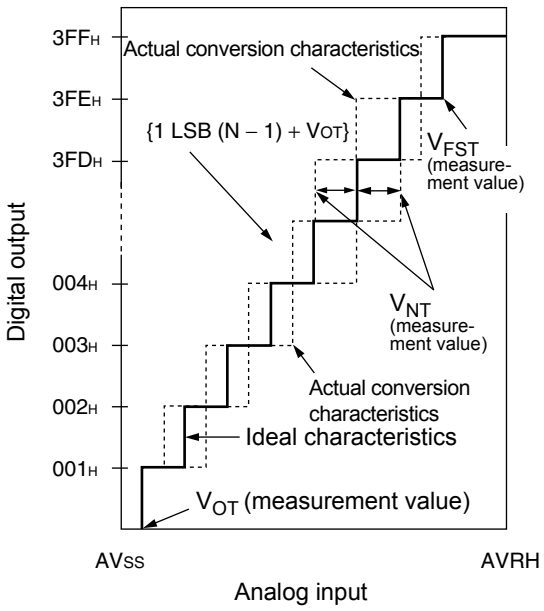
$$1LSB' \text{ (ideal value)} = \frac{AVRH - AV_{SS}}{1024} \text{ [V]}$$

$$\text{Total error of digital output N} = \frac{V_{NT} - \{1\ LSB' \ (N - 1) + 0.5\ LSB'\}}{1\ LSB'}$$

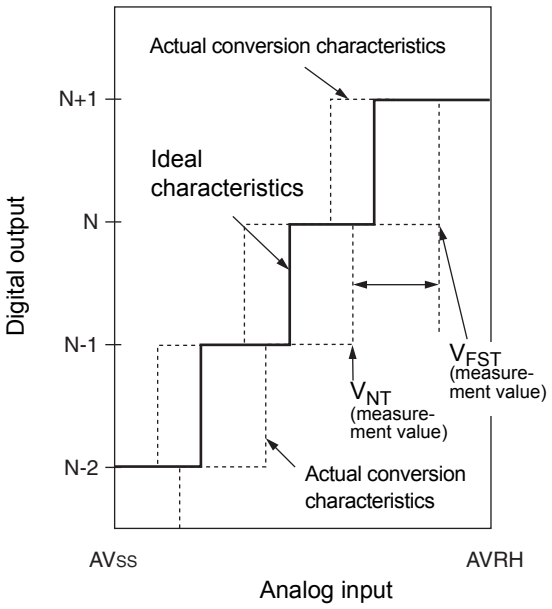
N: A/D converter digital output value
V_{OT}' (ideal value) = AV_{SS} + 0.5 LSB' [V]
V_{FST}' (ideal value) = AVRH – 1.5 LSB' [V]
V_{NT}: A voltage at which digital output transits from (N + 1) to N

(Continued)

Linearity error



Differential linearity error



$$\text{Linearity error of digital output N} = \frac{V_{NT} - \{1\text{LSB} \quad (N - 1) + V_{OT}\}}{1\text{LSB}} [\text{LSB}]$$

$$\text{Differential linearity error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\text{LSB}} [\text{LSB}]$$

$$1\text{LSB} = \frac{V_{FST} - V_{OT}}{1022} [\text{V}]$$

N: A/D converter digital output value
V_{OT} : A voltage at which digital output transits from 000_H to 001_H.
V_{FST} : A voltage at which digital output transits from $3FE_H$ to $3FF_H$.

15.8 Flash Memory Program/Erase Characteristics

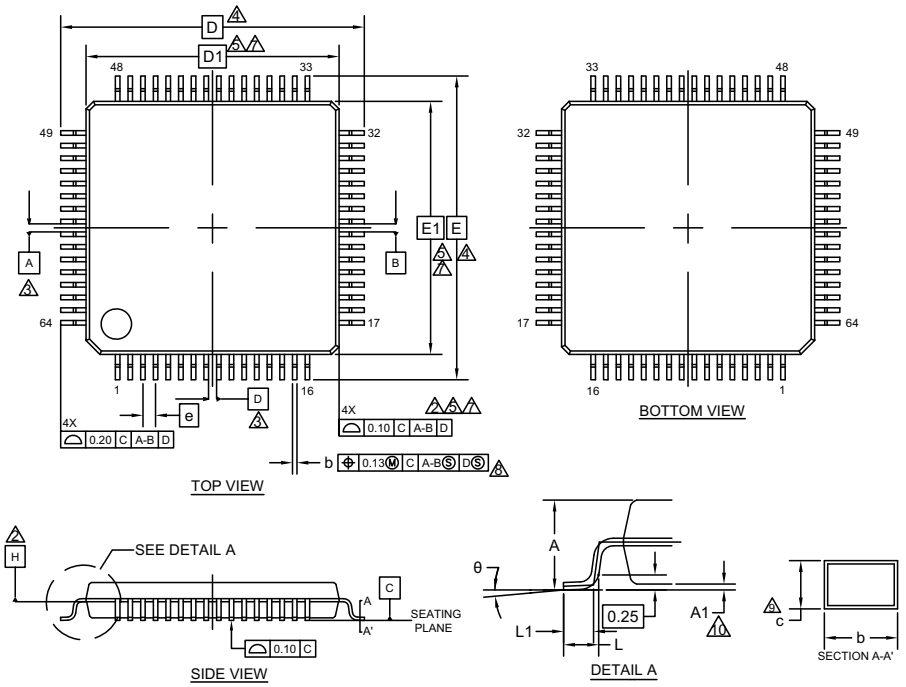
Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	–	0.9	3.6	s	Excludes programming prior to erasure
Chip erase time		–	9	–	s	Excludes programming prior to erasure
Word (16-bit width) programming time		–	23	370	µs	Except for the overhead time of the system level
Program/Erase cycle	–	10000	–	–	cycle	
Flash memory data retention time	Average T_A = + 85 °C	20	–	–	year	[1]

1. The value is translated high-temperature measurement results of the technology reliability evaluation into average value at + 85 °C.

16. Ordering Information

Part Number	Package	Remarks
CY91F463NAPMC-GS-UJE1	64-pin plastic LQFP (LQG064)	Lead-free package
CY91F463NCPMC-GS-UJE1	64-pin plastic LQFP (LQG064)	Lead-free package

17. Package Dimension



SYMBOL	DIMENSION		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.00	—	0.20
b	0.27	0.32	0.37
c	0.09	—	0.20
D	14.00 BSC		
D1	12.00 BSC		
e	0.65 BSC		
E	14.00 BSC		
E1	12.00 BSC		
L	0.45	0.60	0.75
L1	0.30	0.50	0.70
θ	0°	—	8°

NOTES

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-13881 **

PACKAGE OUTLINE, 64 LEAD LQFP
12.0X12.0X1.7 MM LQG064 REV**

18. Main Changes in This Edition

Spansion Publication Number: **DS07-16607-4E**

Page	Section	Change Results
–	–	Changed the part number. MB91F463NB → MB91F463NC
11	I/O Circuit Type Type J	Corrected “invertor for clock input (Xout)” to “hysteresis type”.
35	Memory Space	Added the sector configuration for MB91F463NC in “3. flash memory sector configuration”.
81	Ordering Information	Changed the part number. MB91F463NBPMC → MB91F463NCPMC-GSE1

NOTE: Please see “Document History” for later revised information.

Page	Section	Change Results
Rev.*B		
-	Marketing Part Numbers changed from an MB prefix to a CY prefix	
2, 6, 77, 78	Features 2. Pin Assignment 16. Ordering Information 17. Package Dimensions	Package description modified to JEDEC description. FPT-64P-M23→ LQG064
77	16. Ordering Information	Revised Marketing Part Numbers as follows: Before) - MB91F463NCPMC-GSE1 After) - CY91F463NCPMC-GS-UJE1 Added Marketing Part Numbers as follows: - CY91F463NAPMC-GS-UJE1

Document History

Document Title: CY91F463NA/F463NC/V460A, FR60, CY91460N Series, 32-bit Microcontroller Datasheet Document Number: 002-04604				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	06/29/2009	Migrated to Cypress and assigned document number 002-04604. No change to document contents or format.
*A	5208752	AKIH	04/07/2016	Updated to Cypress template
*B	6168325	WAFA	05/15/2018	Revised the following items: Marketing Part Numbers changed from an MB prefix to a CY prefix. Features 2. Pin Assignment 16. Ordering Information 17. Package Dimensions For details, please see 18. Main Changes in This Edition.

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